

Rain-/Light-Sensor IC for Automotive

Features and Benefits

- ☐ Two independent simultaneously operating Rain measurement channels
- ☐ Integrated DC light cancellation circuitry for Rain channel DC light suppression
- ☐ Integrated compensation for DC light induced photodiode gain modulation
- ☐ Three logarithmic ambient light channels
- ☐ High input capacitance tolerant input current terminals
- Extremely high degree of adaptability for different optical systems

- Standby and Sleep Modes
- Integrated 32Bit OTP
- ☐ Integrated 16Bit ADC
- □ Integrated temperature sensor
- ☐ Easy digital communication interface via SPI
- Integrated watchdog timer
- ☐ High safety design by comprehensive diagnostic and monitoring functions
- Minimum amount of external components
- ☐ Small-size SMD package QFN24 4x4

Ordering Information

Part No. Temperature Code MLX75308 R (-40 °C to 105 °C)

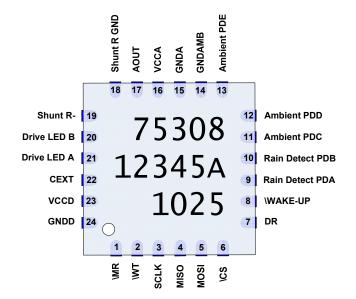
Package Code LQ (QFN24 4x4) Option code

В.

Application Examples

- □ Optical Rain-detection Systems
- Optical Liquid Level metering
- Ambient Light Sensing (Global Irradiation)
- □ Ambient Light Sensing (Forefield Sensor)
- Logarithmic Current Sensing

Pin Description - Top View



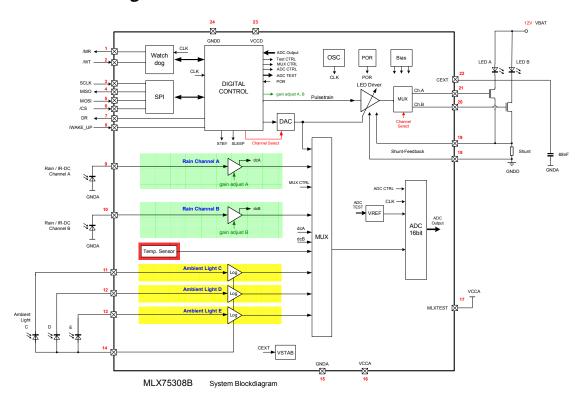
General Description

The MLX75308 IC consists of two optical sensor parts. Part one is optimized for optical rain detection and is designed to transmit and receive modulated light signals used for optical rain detection. The rain detection feature is available in two independent operating measurement input-channels A and B.

Part two consists of three logarithmic current sensors C, D and E, which can measure the photocurrent of externally connected photodiodes. Simple operation is ensured by internal control logic, configurable user registers and SPI communication.

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Functional Diagram



1 General Description

The sensor detects the accumulation of moisture on the windscreen of a car by optical signal transmission and measurement. The system provides data to adjust the wiping rate depending on the amount of precipitation on the windscreen and the driver's selection of wiper sensitivity. The rain sensor works in conjunction with a microcontroller to control the optical energy transmitted by infrared emitters through the windscreen to target infrared detectors, processes the received infrared signal and provides this information back to the microcontroller.

The light sensor determines the ambient light level in the prescribed directions and provides data to control the headlights. For this application a wide range of different detectors can be connected to the ambient sensor terminals of the device.

The IC provides various auxiliary circuit functions to support the main mission of the Rain Light Sensor, for example, a watchdog function, bias and reference sources and clock generators to control and drive the various on-chip functions. In addition, an SPI Interface is included to support data exchange between the IC and the microcontroller.





Rain-/Light-Sensor IC for Automotive

Table of Contents

1 General Description	
2 Glossary of Terms	!
3 Absolute Maximum Ratings	(
4 Pin Definitions and Descriptions	(
5 General Electrical Specifications	9
6 Sensor Specific Specifications	10
7 Detailed General Description	1
7.1 Analog Sensor Functions	1
7.1.1 Rain Sensor	1
7.1.1.1 Rain Channel DC Light measurement	
7.1.2 Rain Channel DC Light compensation	16
7.1.3 LPF- Low Pass Anti-aliasing Filter	18
7.1.4 S-C biquad Low-pass filter	19
7.1.5 Ambient Light Sensor	19
7.1.5.1 Normal operation	19
7.1.5.2 (Ambient light) Buffer autozeroing	19
7.1.5.3 Calibration and temperature compensation	20
7.1.5.4 Response time	20
7.1.5.5 Diagnostics mode operation	2 [.]
7.1.6 Temperature Sensor	23
7.1.7 DAC	24
7.1.8 LED Driver	2
7.1.9 POR	2
7.2 SPI	2
7.2.1 General description of SPI interface	2
7.2.2 Detailed explanation of SPI Instruction Words	32
7.2.2.1 NOP – Idle Command	32
7.2.2.2 CR - Chip Reset Command	32
7.2.2.3 RSLP/CSLP - Request Sleep/Confirm Sleep	32
7.2.2.4 RSTBY/CSTBY - Request Standby/Confirm Standby	30
7.2.2.5 NRM – Normal Running Mode	33
7.2.2.6 SM – Start Measurement	33
7.0.0.7.DO Chart Board Out	3!
7.2.2.7 NO - Start Read-Out	
7.2.2.7 RO – Start Read-Out	3
7.2.2.8 SM+RO - Start Measurement combined with Read-Out	3 ⁷
7.2.2.8 SM+RO - Start Measurement combined with Read-Out	3 ¹ 38 39
7.2.2.8 SM+RO - Start Measurement combined with Read-Out	3 ¹ 38 39
7.2.2.8 SM+RO - Start Measurement combined with Read-Out	3: 3! 4:
7.2.2.8 SM+RO - Start Measurement combined with Read-Out	3: 3! 4:
7.2.2.8 SM+RO - Start Measurement combined with Read-Out	33 38 4 44
7.2.2.8 SM+RO - Start Measurement combined with Read-Out	31 38 4 4 44 44
7.2.2.8 SM+RO - Start Measurement combined with Read-Out	31 38 4 4 44 44
7.2.2.8 SM+RO - Start Measurement combined with Read-Out	3: 3: 4: 4: 4: 4!
7.2.2.8 SM+RO - Start Measurement combined with Read-Out	3: 3! 4: 4: 4! 4!
7.2.2.8 SM+RO - Start Measurement combined with Read-Out 7.2.2.9 WR/RR — Write/Read Register. 7.2.2.10 SD — Start Diagnostics. 7.3 Internal Status Flags 7.4 User Registers Overview 7.4.1 SetAna register 7.4.2 SetAH register. 7.4.3 SetAL register. 7.4.4 SetBH register. 7.4.5 SetBL register 7.4.6 SetPF register 7.4.6 SetPF register. 7.4.7 Err register	33334444444
7.2.2.8 SM+RO - Start Measurement combined with Read-Out 7.2.2.9 WR/RR — Write/Read Register. 7.2.2.10 SD — Start Diagnostics. 7.3 Internal Status Flags 7.4 User Registers Overview 7.4.1 SetAna register 7.4.2 SetAH register. 7.4.3 SetAL register. 7.4.4 SetBH register. 7.4.5 SetBL register 7.4.6 SetPF register 7.4.6 SetPF register. 7.4.7 Err register	33334444444
7.2.2.8 SM+RO - Start Measurement combined with Read-Out 7.2.2.9 WR/RR — Write/Read Register. 7.2.2.10 SD — Start Diagnostics. 7.3 Internal Status Flags 7.4 User Registers Overview 7.4.1 SetAna register 7.4.2 SetAH register. 7.4.3 SetAL register. 7.4.4 SetBH register. 7.4.5 SetBL register 7.4.7 SetBL register 7.4.8 SetPF register 7.4.8 SetPF register 7.4.8 Rst register 7.4.8 Rst register	33334444444444.
7.2.2.8 SM+RO - Start Measurement combined with Read-Out 7.2.2.9 WR/RR — Write/Read Register. 7.2.2.10 SD — Start Diagnostics. 7.3 Internal Status Flags 7.4 User Registers Overview. 7.4.1 SetAna register 7.4.2 SetAH register. 7.4.3 SetAL register. 7.4.4 SetBH register. 7.4.5 SetBL register. 7.4.7 SetBH register. 7.4.8 SetBH register. 7.4.8 Rst register. 7.4.8 Rst register. 7.4.9 DCComp register.	33 34 44 44 44 44 44 44 44 44 44
7.2.2.8 SM+RO - Start Measurement combined with Read-Out 7.2.2.9 WR/RR — Write/Read Register. 7.2.2.10 SD — Start Diagnostics. 7.3 Internal Status Flags 7.4 User Registers Overview 7.4.1 SetAna register 7.4.2 SetAH register 7.4.3 SetAL register 7.4.4 SetBH register 7.4.5 SetBL register 7.4.6 SetPF register 7.4.6 SetPF register 7.4.7 Err register 7.4.8 Rst register 7.4.9 DCComp register 7.4.10 GainBuf register 7.4.11 Calib1/Calib2 register	33 34 44 44 44 44 46 41 41 45 55
7.2.2.8 SM+RO - Start Measurement combined with Read-Out 7.2.2.9 WR/RR — Write/Read Register. 7.2.2.10 SD — Start Diagnostics. 7.3 Internal Status Flags 7.4 User Registers Overview 7.4.1 SetAna register 7.4.2 SetAH register. 7.4.3 SetAL register 7.4.4 SetBH register 7.4.4 SetBH register 7.4.5 SetBL register 7.4.6 SetPF register 7.4.7 Err register 7.4.8 Rst register 7.4.9 DCComp register 7.4.10 GainBuf register 7.4.11 Calib1/Calib2 register 7.4.12 EnChan register	33 34 44 44 44 44 41 41 45 55
7.2.2.8 SM+RO - Start Measurement combined with Read-Out 7.2.2.9 WR/RR — Write/Read Register. 7.2.2.10 SD — Start Diagnostics. 7.3 Internal Status Flags 7.4 User Registers Overview 7.4.1 SetAna register 7.4.2 SetAH register. 7.4.3 SetAL register 7.4.4 SetBH register 7.4.4 SetBH register 7.4.5 SetBL register 7.4.6 SetPF register 7.4.7 Err register 7.4.8 Rst register 7.4.9 DCComp register 7.4.10 GainBuf register 7.4.11 Calib1/Calib2 register 7.4.12 EnChan register	33 34 44 44 44 44 41 41 45 55
7.2.2.8 SM+RO - Start Measurement combined with Read-Out 7.2.2.9 WR/RR — Write/Read Register. 7.2.2.10 SD — Start Diagnostics. 7.3 Internal Status Flags 7.4 User Registers Overview 7.4.1 SetAna register 7.4.2 SetAH register 7.4.3 SetAL register 7.4.4 SetBH register 7.4.5 SetBL register 7.4.6 SetPF register 7.4.6 SetPF register 7.4.7 Err register 7.4.8 Rst register 7.4.9 DCComp register 7.4.10 GainBuf register 7.4.11 Calib1/Calib2 register	33 33 4 44 44 44 44 44 45 55 55
7.2.2.8 SM+RO - Start Measurement combined with Read-Out 7.2.2.9 WR/RR — Write/Read Register. 7.2.2.10 SD — Start Diagnostics. 7.3 Internal Status Flags 7.4 User Registers Overview 7.4.1 SetAna register 7.4.2 SetAH register. 7.4.3 SetAL register 7.4.4 SetBH register 7.4.4 SetBH register 7.4.5 SetBL register 7.4.6 SetPF register 7.4.7 Err register 7.4.8 Rst register 7.4.9 DCComp register 7.4.10 GainBuf register 7.4.11 Calib1/Calib2 register 7.4.12 EnChan register 7.4.13 Tamb register	33 34 44 44 44 44 44 44 45 55 55 55
7.2.2.8 SM+RO - Start Measurement combined with Read-Out 7.2.2.9 WR/RR — Write/Read Register. 7.2.2.10 SD — Start Diagnostics. 7.3 Internal Status Flags 7.4 User Registers Overview 7.4.1 SetAna register 7.4.2 SetAH register. 7.4.3 SetAL register. 7.4.4 SetBH register. 7.4.4 SetBH register 7.4.5 SetBL register 7.4.6 SetPF register 7.4.7 Err register 7.4.8 Rst register 7.4.9 DCComp register 7.4.10 GainBuf register 7.4.11 Calib1/Calib2 register 7.4.12 EnChan register 7.4.13 Tamb register 7.4.13 Tamb register 7.5 Window Watchdog Timer	33 34 44 44 44 44 44 45 55 55 55
7.2.2.8 SM+RO - Start Measurement combined with Read-Out 7.2.2.9 WR/RR – Write/Read Register 7.2.2.10 SD – Start Diagnostics 7.3 Internal Status Flags 7.4 User Registers Overview 7.4.1 SetAna register 7.4.2 SetAH register 7.4.3 SetAL register 7.4.4 SetBH register 7.4.5 SetBL register 7.4.5 SetBL register 7.4.6 SetPF register 7.4.7 Err register 7.4.8 Rst register 7.4.9 DCComp register 7.4.10 GainBuf register 7.4.11 Calib1/Calib2 register 7.4.12 EnChan register 7.4.13 Tamb register 7.4.13 Tamb register 7.5 Window Watchdog Timer 7.6 Reset Behaviour	33 34 43 44 44 44 44 44 45 55 55 55 56
7.2.2.8 SM+RO - Start Measurement combined with Read-Out 7.2.2.9 WR/RR — Write/Read Register 7.2.2.10 SD — Start Diagnostics 7.3 Internal Status Flags 7.4 User Registers Overview 7.4.1 SetAna register 7.4.2 SetAH register 7.4.2 SetAH register 7.4.3 SetAL register 7.4.4 SetBH register 7.4.5 SetBL register 7.4.5 SetBL register 7.4.6 SetPF register 7.4.7 Err register 7.4.7 Err register 7.4.9 DCComp register 7.4.10 GainBuf register 7.4.11 Calib1/Calib2 register 7.4.12 EnChan register 7.4.13 Tamb register 7.5 Window Watchdog Timer 7.6 Reset Behaviour 7.7 Wake-up from Sleep or Standby	33 34 44 44 44 44 44 45 55 55 55 56 66
7.2.2.8 SM+RO - Start Measurement combined with Read-Out 7.2.2.9 WR/RR — Write/Read Register. 7.2.2.10 SD — Start Diagnostics	33 34 44 44 44 44 44 45 55 55 56 66 66
7.2.2.8 SM+RO - Start Measurement combined with Read-Out 7.2.2.9 WR/RR – Write/Read Register. 7.2.2.10 SD – Start Diagnostics 7.3 Internal Status Flags	33 34 44 44 44 44 44 45 55 55 56 66 66
7.2.2.8 SM+RO - Start Measurement combined with Read-Out 7.2.2.9 WR/RR — Write/Read Register 7.2.2.10 SD — Start Diagnostics 7.3 Internal Status Flags 7.4 User Registers Overview 7.4.1 SetAna register 7.4.2 SetAH register 7.4.3 SetAL register 7.4.4 SetBH register 7.4.5 SetBL register 7.4.6 SetPF register 7.4.6 SetPF register 7.4.7 Err register 7.4.8 Rst register 7.4.9 DCComp register 7.4.10 GainBuf register 7.4.10 GainBuf register 7.4.11 Calib1/Calib2 register 7.4.12 EnChan register 7.4.13 Tamb register 7.4.13 Tamb register 7.5 Window Watchdog Timer 7.6 Reset Behaviour 7.7 Wake-up from Sleep or Standby 7.8 CRC Calculation 7.9 Global Timing Diagrams	33 34 44 44 44 44 45 55 55 56 66 66
7.2.2.8 SM+RO - Start Measurement combined with Read-Out. 7.2.2.9 WR/RR — Write/Read Register. 7.2.10 SD — Start Diagnostics. 7.3 Internal Status Flags 7.4 User Registers Overview 7.4.1 SetAna register. 7.4.2 SetAH register. 7.4.3 SetAL register. 7.4.5 SetBL register. 7.4.5 SetBL register. 7.4.6 SetPF register. 7.4.6 SetPF register. 7.4.7 Err register. 7.4.9 DCComp register. 7.4.10 GainBuf register. 7.4.11 Calib1/Calib2 register. 7.4.11 Calib1/Calib2 register. 7.4.12 EnChan register. 7.4.13 Tamb register. 7.4.13 Tamb register. 7.5 Window Watchdog Timer 7.6 Reset Behaviour. 7.7 Wake-up from Sleep or Standby 7.8 CRC Calculation. 7.9 Global Timing Diagrams. 8 Unique Features. 9 Performance Graphs. 9 Performance Graphs. 9 Performance Graphs. 9 Performance Graphs.	33 34 44 44 44 44 45 55 55 55 56 66 66
7.2.2.8 SM+RO - Start Measurement combined with Read-Out. 7.2.2.9 WR/RR — Write/Read Register. 7.2.2.10 SD — Start Diagnostics. 7.3 Internal Status Flags. 7.4 User Registers Overview. 7.4.1 SetAhar egister. 7.4.2 SetAH register. 7.4.3 SetAL register. 7.4.5 SetBH register. 7.4.5 SetBL register. 7.4.6 SetPF register. 7.4.6 SetPF register. 7.4.7 Err register. 7.4.9 DCComp register. 7.4.10 GainBuf register. 7.4.11 Calib1/Calib2 register. 7.4.11 Calib1/Calib2 register. 7.4.12 EnChan register. 7.4.13 Tamb register. 7.5 Window Watchdog Timer 7.6 Reset Behaviour. 7.7 Wake-up from Sleep or Standby 7.8 CRC Calculation. 7.9 Global Timing Diagrams. 8 Unique Features. 9 Performance Graphs. 9.1 Rain Channel DC Measurement. 9.2 Temperature Sensor Characteristics.	33 34 44 44 44 44 44 45 55 55 55 56 66 66 66
7.2.2.8 M+RO - Start Measurement combined with Read-Out. 7.2.2.9 WR/RR – Write/Read Register 7.2.2.10 SD – Start Diagnostics 7.3 Internal Status Flags 7.4 User Registers Overview. 7.4.1 SetAna register 7.4.2 SetAH register 7.4.3 SetAL register 7.4.5 SetBL register 7.4.5 SetBL register 7.4.6 SetPF register 7.4.6 SetPF register 7.4.7 Err register 7.4.8 Rst register 7.4.10 GainBuf register 7.4.10 GainBuf register 7.4.11 Galib1/Calib2 register 7.4.12 EnChan register 7.4.13 Tamb register 7.5 Window Watchdog Timer 7.6 Reset Behaviour 7.7 Wake-up from Sleep or Standby 7.8 CRC Calculation 7.9 Global Timing Diagrams 8 Unique Features 9 Performance Graphs 9.1 Rain Channel DC Measurement 9.2 Temperature Sensor Characteristics 9.3 Ambient Light Channel C	33 34 44 44 44 44 44 45 55 55 55 56 66 66 66 66
7.2.2.8 WH-RO - Start Measurement combined with Read-Out. 7.2.2.9 WR/RR - Write/Read Register. 7.2.10 SD - Start Diagnostics. 7.3 Internal Status Flags 7.4 User Registers Overview. 7.4.1 SetNan register. 7.4.2 SetAH register. 7.4.3 SetAL register. 7.4.4 SetBH register. 7.4.5 SetBL register. 7.4.5 SetBL register. 7.4.6 SetPF register. 7.4.7 Err register. 7.4.7 Err register. 7.4.8 Rst register. 7.4.9 DCComp register. 7.4.10 GainBuf register. 7.4.11 Calib1/Calib2 register. 7.4.12 EnChan register. 7.4.13 Tamb register. 7.5 Window Watchdog Timer 7.6 Reset Behaviour. 7.7 Wake-up from Sleep or Standby. 7.8 CRC Calculation. 7.9 Global Timing Diagrams. 8 Unique Features. 9 Performance Graphs. 9.1 Rain Channel DC Measurement. 9.2 Temperature Sensor Characteristics. 9.3 Ambient Light Channel C.	33 34 44 44 44 44 44 45 55 55 56 66 66 66
7.2.2.8 WH-RD - Start Measurement combined with Read-Out. 7.2.2.9 WR/RR - Write/Read Register 7.2.10 SD - Start Diagnostics. 7.3 Internal Status Flags 7.4 User Registers Overview 7.4.1 StetAn register 7.4.2 SetAH register 7.4.2 SetBH register 7.4.5 SetBL register 7.4.5 SetBL register 7.4.6 SetPF register 7.4.7 Fir register 7.4.7 Err register 7.4.8 Rst register 7.4.9 DCComp register 7.4.10 GainBuf register 7.4.11 Gailbuf Calibus Pregister 7.4.12 EnChan register 7.4.12 EnChan register 7.5 Window Watchdog Timer 7.6 Reset Behaviour 7.7 Wake-up from Sleep or Standby 7.8 CRC Calculation 7.9 Global Timing Diagrams 8 Unique Features 9 Performance Graphs 9.1 Rain Channel DC Measurement 9.2 Temperature Sensor Characteristics 9.3 Ambient Light Channel C 9.4 Ambient Light Channel D+E 9.5 DC Light Compensation (BP104FS)	33 34 44 44 44 44 44 45 55 55 56 66 66 66 66
7.2.2.8 SM+RO - Start Measurement combined with Read-Out. 7.2.2.9 WR/RR - Write/Read Register 7.2.2.10 SD - Start Diagnostics 7.3 Internal Status Flags 7.4 User Registers Overview. 7.4.1 SetAna register 7.4.2 SetAH register. 7.4.3 SetAL register. 7.4.4 SetBH register. 7.4.4 SetBH register. 7.4.5 SetBL register 7.4.5 SetBL register 7.4.6 SetPF register 7.4.7 SetPer register 7.4.7 Ber register 7.4.8 Rst register 7.4.9 DCComp register 7.4.10 CainBuf register 7.4.11 Calib1/Calib2 register 7.4.11 Talib1/Calib2 register 7.4.12 EnChan register 7.4.13 Tamb register 7.4.13 Tamb register 7.5 Window Watchdog Timer 7.6 Reset Behaviour 7.7 Wake-up from Sleep or Standby 7.8 CRC Calculation. 7.9 Global Timing Diagrams 8 Unique Features 9 Performance Graphs 9.1 Rain Channel DC Measurement 9.2 Temperature Sensor Characteristics 9.3 Ambient Light Channel D-E 9.5 DC Light Compensation (BP104FS) 9.6 DC Light Compensation (BP104FS) 9.6 DC Light Compensation (BP104FS)	33 34 33 44 44 44 44 45 55 55 55 56 66 66 66 66
7.2.2.8 WH-RD - Start Measurement combined with Read-Out. 7.2.2.9 WR/RR - Write/Read Register 7.2.10 SD - Start Diagnostics. 7.3 Internal Status Flags 7.4 User Registers Overview 7.4.1 StetAn register 7.4.2 SetAH register 7.4.2 SetBH register 7.4.5 SetBL register 7.4.5 SetBL register 7.4.6 SetPF register 7.4.7 Fir register 7.4.7 Err register 7.4.8 Rst register 7.4.9 DCComp register 7.4.10 GainBuf register 7.4.11 Gailbuf Calibus Pregister 7.4.12 EnChan register 7.4.12 EnChan register 7.5 Window Watchdog Timer 7.6 Reset Behaviour 7.7 Wake-up from Sleep or Standby 7.8 CRC Calculation 7.9 Global Timing Diagrams 8 Unique Features 9 Performance Graphs 9.1 Rain Channel DC Measurement 9.2 Temperature Sensor Characteristics 9.3 Ambient Light Channel C 9.4 Ambient Light Channel D+E 9.5 DC Light Compensation (BP104FS)	33 34 33 44 44 44 44 45 55 55 55 56 66 66 66 66 66



Rain-/Light-Sensor IC for Automotive

10 Application Information	66
10.1 Application circuit for typ. rain channel and three ambient channels	66
10.2 Application circuit for typ. rain channel and two ambient channels	67
11 Application Comments	68
12 Standard information regarding manufacturability of Melexis products with different soldering processes	69
13 ESD Precautions	
14 FAQ	70
15 Package Information	
16 Disclaimer	70



Rain-/Light-Sensor IC for Automotive

2 Glossary of Terms

ADC Analog-Digital converter

CR Chip Reset

CRC Cyclic Redundancy Check

CS Chip Select
CSLP Confirm Sleep
CSTBY Confirm Standby
CTRL Control Signal

DAC Digital to Analog Converter

DC Direct Current DR Device Ready

EMC Electromagnetic Compatibility

GNDA Ground for analog Blocks of MLX75308
GNDD Ground for digital Blocks of MLX75308

IR Infrared

LED Light emitting diode LPF Low-pass filter LSB Least Significant Bit Master In Slave Out MISO MOSI Master Out Slave In MR Master Reset Most Significant Bit MSB MUX Multiplexer NOP No Operation NP Number of Pulses NRM Normal Running Mode

OSC Oscillator

OTP One time programmable OTR Optical transfer ratio

PDPhotodiode POR Power on reset **RCO** RC-Oscillator RO Read-Out Read Register RR **RSLP** Request Sleep **RSTBY** Request Standby S&H Sample and Hold SCLK SPI Shift Clock

SC-LPF Switched Capacitor biquad Low-pass filter

SM Start Measurement
SNR Signal-to-Noise Ratio
SPI Serial Peripheral Interface
TIA Transimpedance Amplifier

VBATT_30 VBATT which is supplied from connection 30 of the car

VCCA Supply Voltage for the analog blocks VCCD Supply Voltage for the digital blocks

VDD_30 VDD which is supplied from connection 30 of the car

VSENSE Voltage across the shunt resistor

WDT Watchdog Timer
WR Write Register
WT Watchdog Trigger
uC Microcontroller



3 Absolute Maximum Ratings

Parameter	Symbol	Condition	Min	Max	Units
Supply voltage range	V_{DD}		-0.3	5.0	V
Terminal current	Iterminal	per bondpad	-20	+20	mA
Terminal voltage	V _{terminal}	Pins 1-8, 14-24	-0.3	V _{DD} +0.3	V
		Pins 9-13 ¹	-0.3	V _{DD} +0.3	V
Storage temperature	T _{stg}		-40	+150	°C
Junction temperature	Tj			+150	°C
Power dissipation ²	P _{tot}	For max ambient temperature of 100°C and Teta_ja = 154K/W		320	mW
ESD capability of any pin (Human Body Model)	ESD _{HBM}	Human body model, acc. to AEC-Q100-002	-2	2	kV
		Pins 9-13	-1	1	kV
ESD capability of any pin (Charge device model)	ESD _{CDM}	Charge device model acc. to AEC- Q100-011	-750	+750	V
Maximum latch-up free current at any pin	ILATCH	JEDEC- Standard EIA / JESD78	-100	+100	mA

Table 1: Absolute maximum ratings

Exceeding the absolute maximum ratings may cause permanent damage. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

4 Pin Definitions and Descriptions

Pin №	Name	Functional Schematic	Туре	Function
1	\MR	PAD	Digital Output	Master Reset
2	\WT	PAD #	Digital Input	Watchdog Trigger
3	SCLK	PAD	Digital Input	SPI Shift Clock

¹ Pins 9-13 require special care with regard to the used ESD protection devices, since these nodes of the design are very sensitive to substrate noise and/or leakage currents.

 $^{^2}$ The Power dissipation is valid for $\vartheta_{
m JA}$ values for the 24 Pin QFN 4x4 package according to Table 27.



Rain-/Light-Sensor IC for Automotive

	T		T .	T
4	MISO	PAD PAD	Digital Output	SPI Data Output
5	MOSI	PAD T	Digital Input	SPI Data Input
6	\CS	PAD T	Digital Input	Chip Select
7	DR	PAD PAD	Digital Output	Device Ready
8	\WAKE-UP	PAD T	Digital Input	Normal Mode
9	Rain Detect PDA	920	Analog Input	IR Photo Diode A
10	Rain Detect PDB	PAC A	Analog Input	IR Photo Diode B
11	Ambient PDC	720 *	Analog Input	Ambient Light Photo Diode C
12	Ambient PDD	720 *	Analog Input	Ambient Light Photo Diode D
13	Ambient PDE	© ★	Analog Input	Ambient Light Photo Diode E
14	GNDAMB	PAD PAD	Analog I/O	Ground Ambient Light Channels
15	GNDA		Ground	Ground
16	VCCA		Supply	Regulated Power Supply



Rain-/Light-Sensor IC for Automotive

17	AOUT		Analog I/O	Analog Test Output, connect to VCCA
18	Shunt R GND	710	Analog Input	Shunt resistor feedback to Ground
19	Shunt R-	**************************************	Analog Input	Shunt resistor feedback
20	Drive LED B	PAO	Analog Output	IR LED Emitter B
21	Drive LED A	PAO	Analog Output	IR LED Emitter A
22	CEXT	750 X	Analog Input	External blocking Cap, connected to GNDA
23	VCCD		Supply	Regulated external Power Supply
24	GNDD		Ground	Ground

Table 2: Pin definitions and descriptions

Rain-/Light-Sensor IC for Automotive

5 General Electrical Specifications

DC Operating Parameters $T_A = -40^{\circ} C$ to $105^{\circ} C$, $V_{DD} = 3.0 V$ to 3.6 V (unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Supply Voltage range	V_{DD}		3.0	3.3	3.6	V
Supply Current (active Mode)	I _{DD}	without photodiode dc current			6	mA
Standby Current	I _{SBY}	@ Vcc=3.6V, T=30°C			500	uA
Sleep Current	Isleep	@ Vcc=3.6V, T=30°C			50	uA
Operation Temperature Range	TA		-40		105	°C
Pull-up resistor	Rpu	for SCLK and \CS		50k		Ohm
Pull-down resistor	Rpd	for MOSI		50k		Ohm
Start-up time after power-on	t _{startup}		-5%	50	+5%	ms
Start-up time after power-on for SPI	tstartup_SPI				10	μs
Start-up time after wake-up from sleep	twakeup_slp		-5%	50	+5%	ms
Start-up time after wake-up from standby	twakeup_stby		-5%	50	+5%	ms
High-level Input Voltage	V _{IH}		0.7 V _{DD}		V_{DD}	V
Low-level Input Voltage	V _{IL}		0		0.3 V _{DD}	V
Hysteresis on Digital Inputs	V _{HYST}			0.28		V
High Output Voltage (not on pin MR)	VoH	C _L =30pF	0.8 V _{DD}		V_{DD}	V
Low Output Voltage (not on pin MR)	VoL	C _L =30pF	0		0.2 V _{DD}	V
Input leakage	I _{LK}		-10		10	μA
Tri-state Output Leakage Current	loz		-10		10	μA
Input Capacitance, per Pin	Cin			10		pF
Output voltage Low, Pin MR	V _{OutL}	I _{ODC} =2mA			0.1	V

Table 3: Electrical specifications



Rain-/Light-Sensor IC for Automotive

6 Sensor Specific Specifications

DC Operating Parameters $T_A = -40^{\circ}$ C to 105° C, $V_{DD} = 3.0$ V to 3.6V (unless otherwise specified)

Rain Channels (detectors A and B)									
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units			
Rain signal optical transfer ratio	$OTR = \frac{I_{LED}}{I_{RainPD}}$		30		80000				
DC sunlight signal	Isun		140		900	uA			
fast full scale transition at I _{sunmax}	t _{sunrise}		3.5			ms			
min. relative rain modulation (referred to received IR signal)	$\frac{\Delta I_{Rain_{\min}}}{I_{Rain}}$	- 400Hz BW, - max LED current of 1000mA, - 25°C - DC sun constant - rain response per channel 2.5ms			0.3	%			
dynamic range of rain events (referred to received IR signal)	ΔI_{Rain}				80	%			
Rain measurement repetition time	t _{rep_rain}	channel A, B		2.5		ms			
Carrier frequency range for rain measurement signal	f ₀	selectable via "SetPF" register, see also 7.4.6	45.7		109.4	kHz			
Input capacitance PDA, PDB	C _{PDA,B}				10	pF			
DC light measurement range	I _{DC} range		0		275	uA			
DC light measurement offset	I _{DC} offset	At I _{DC} = 0uA	4096	7168	10240	LSB			
DC light measurement slope	I _{DC sens}		115	150	184	LSB/uA			
DC light measurement linearity error		Idc range: 0uA -> 275uA		5	8	%			
DC light measurement word length				16		Bit			
DC light measurement resolution		for averaging of 8 measurements		13		Bit			
TIA Test pulse	ADC _{TIA_test_00}	T=27°C, DACA6=0, DACA7=0 Gain Anti Aliasing Filter=2 ADC Buffer bypassed	35035	36182	37570	LSB			
TC TIA Test pulse	TC ADC _{TIA_test_00}	DACA6=0, DACA7=0 Gain Anti Aliasing Filter=2 ADC Buffer bypassed		2.78		LSB/K			
TIA Test pulse step width	ADCTIA_test_step	T=27°C, Gain Anti Aliasing Filter=2 ADC Buffer bypassed	4458	5932	7770	LSB			
TC TIA Test pulse step width	TC ADC _{TIA_test_step}	Gain Anti Aliasing Filter=2 ADC Buffer bypassed		4.8		LSB/K			

Error condition Err6

Critical error detected on TIA output, is TIA output outside 1.1V+/- (0.65 ... 0.75V)

Note: Critical error may occur if the referring Rain Channel is disabled and the according diagnostic function is enabled (see EnChan register).

Critical error may occur after enabling of the referring Rain Channel due to analog settling time.

Table 4: Rain sensor channels specifications



Rain-/Light-Sensor IC for Automotive

Rain-Channel DC-Light Compensation									
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units			
Maximum Rain Signal DC-Light compensation range	RS _{COMP_max}	in percent of LED current DC_COMP_IC1,2,3,4,5=15 DAC=255	15	20		%			
Rain Signal Compensation Offset	RScomp_offset	in percent of LED current @ Idc = 0uA			0.8	%			
Range of segment 1	lamb_1	1 ^{rst} corner dc current	7.2	10.0	12.0	uA			
Range of segment 2	lamb_2	2 nd corner dc current	40.0	45.0	50.0	uA			
Range of segment 3	lamb_3	3 rd corner dc current	135.0	150.0	165.0	uA			
Range of segment 4	lamb_4	4th corner dc current	440.0	500.0	560.0	uA			
Full compensation level @ segment 1	lcomp_1	DC_COMP_IC1,2,3,4,5 = 15	1.5	3.5	4.7	%			
Full compensation level @ segment 2	lcomp_2	DAC=255 in percent of LED current	5.1	7.7	10.3	%			
Full compensation level @ segment 3	lcomp_3	In percent of LLD current	9.5	13.7	17.9	%			
Full compensation level @ segment 4	Icomp_4		13.6	18.8	24.0	%			
Full compensation level @ 900uA (max DC sunlight)	lcomp_5		15.0	20.7	25.8	%			
Full compensation level @ segment 1	lcomp_1	DC_COMP_IC1,2,3,4,5 = 7	0.65	1.6	2.2	%			
Full compensation level @ segment 2	lcomp_2	DAC=255	2.4	3.6	4.8	%			
Full compensation level @ segment 3	lcomp_3	in percent of LED current	4.4	6.4	8.4	%			
Full compensation level @ segment 4	lcomp_4		6.3	8.85	11.4	%			
Full compensation level @ 900uA (max DC sunlight)	lcomp_5		7.1	9.6	12.1	%			
DC_COMP_IC1 = 15, other =0	I _{C_1}	in percent of LED current	1.4	2.3	2.8	%			
DC_COMP_IC2 = 15, other =0	I _{C_2}	in percent of LED current	2.1	2.9	3.6	%			
DC_COMP_IC3 = 15, other =0	Ic_3	in percent of LED current	5.0	6.6	8.2	%			
DC_COMP_IC4 = 15, other =0	I _{C_4}	in percent of LED current	4.4	5.9	7.3	%			
DC_COMP_IC5 = 15, other =0	I _{C_5}	in percent of LED current	2.0	3.0	4.1	%			

Table 5: DC light compensation specifications



Rain-/Light-Sensor IC for Automotive

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
nput current range for detectors C	I _{ambc}		0.01		1040	uA
nput current range for detectors D	l _{ambd}		0.0005		20	uA
nput current range for detectors E	l _{ambe}		0.0005		20	uA
nput current threshold level C	I _{ambc_detect}		333			nA
nput current threshold level D	I _{ambd_detect}		5.5			nA
nput current threshold level E	I _{ambe_detect}		5.5			nA
nput capacity on ambient PDC	C _{ambc}	at 1V			1	nF
nput capacity on ambient PDD	C _{ambd}	at 1V			100	pF
nput capacity on ambient PDE	C _{ambe}	at 1V			100	pF
Fransfer function logarithmic	V_{amb}	S	ee section	9.3 and 9).4	
Output Ambient Channel C		At VCC=3,3V, lin=100uA	30464	32768	37376	LSB
Output Ambient Channel D and E		At VCC=3,3V, lin=10uA	30464	32768	37376	LSB
Slope Ambient Channel C		At VCC=3,3V and 105°C	5300	5900	6500	LSB/dec
Slope Ambient Channel D and E		At VCC=3,3V and 105°C	5300	5900	6500	LSB/dec
Ambient Channels Linearity Error		for lin ≥ l _{ambx_detect}		3	5	%
Ambient light word length				16		bits
Ambient light channel resolution		for averaging of 16 measurements		13		bits
Ambient light response time		See section 7.1.5.4 for a detailed explanation of this parameter. for lin ≥ l _{ambx_detect}			3	ms

Table 6: Ambient light channel specifications

Data Sheet

Nov/11

Temperature Sensor								
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units		
Temp. sensor range	θ		-40		105	°C		
Temp. sensor transfer function ³	V _v	@ VDD=3,3V	-82	-67	-51	LSB/K		
Temp. sensor output	V@85°C	@ VDD=3,3V and full Calib1/2 ranges	5990	8097	10203	LSB		
Temp. sensor error	ϑerror@85°C	@ VDD=3,3V			±3	°C		
Temp. response time	$t_{resp_{-\vartheta}}$				1	S		
Temp. sensor word length				16		bits		
Temp. sensor resolution		for averaging of 16 measurements		13		bits		

Table 7: Temperature sensor specifications

LED Driver							
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units	
LED current		Shunt=1 Ω	1.05		993	mA	
Shunt resistor values			1		10	Ohm	
Shunt voltage			1.05		993	mV	
Rising and falling time ⁴				3		us	
DC offset level				1		mV	
Time before pulse	T _{dc_pulse}	See section 7.4.1	47.5		420	us	
	E	xternal important transistor par	ameter				
max gate drain voltage	V _{GS}	VDD=3V			2	V	
Max Gate/Base current	I _{G/B}	VDD=3V			400	uA	
Error condition Err5							
Err5 difference between Vdac a	nd Vsense. Det	ection level larger 100mV					

Table 8: LED driver specifications

This value is stored in the Calib1 Register
 Please have look on Figure 9



Rain-/Light-Sensor IC for Automotive

		SPI					
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units	
SPI word length					8	bit	
SPI Clock Frequency	$f_{SCLK} = 1/t_{SCLK}$		0.5	1	5	MHz	
Frequency of Internal RC Oscillator	$f_{RCO} = 1/T_{RCO}$		-5%	2.5	+5%	MHz	
CS low prior to first SCLK edge	t _{cs_sclk}		50			ns	
CS high after last SCLK edge	t _{sclk_cs}		50			ns	
CS high time between transmissions	t _{cs_inter}		50			ns	
Time between CS high and DR low	t _{cs_dr}		0		21.84 (232us) ⁵	μs	
Min low time on WAKE_UP pin	t _{wu_I}		100			μs	
Min low time on WT pin	t _{wt_l}		10			μs	
WDT initial active window time	twdt_init	After POR, Watchdog Reset and Wake-Up	-5%	140	+5%	ms	
WDT open window time	t _{wdt_open}		-5%	70	+5%	ms	
WDT closed window time	twdt_closed		-5%	70	+5%	ms	
MR low time during reset	t _{MR}	After Watchdog Reset	-5%	2	+5%	ms	
Error condition Err2							
RCO stuck at High or Low							
	Error c	ondition Err4					
internal voltage regulator : err4 is set if the	e regulator does not s	start (detection threshold	in the rar	nge [1V;2V])		

Table 9: Serial peripheral interface specifications

Page 14 of 72

Data Sheet Nov/11

 $^{^{5}}$ with random measurement start, the max time can be up to 232us, if an autozeroing phase of the IC is executed.

Rain-/Light-Sensor IC for Automotive

7 Detailed General Description

7.1 Analog Sensor Functions

7.1.1 Rain Sensor

The MLX75308 works with two separate transmit- and receive-channels A and B. In order to perform a rain measurement, carrier modulated light signal bursts are transmitted by the LED(s) and received by the rain channel detectors connected to the pins 9 and 10. Both receive-channels can work parallel or separate.

The rain channels are low pass systems. The carrier based burst signals, which are amplified by the transimpedance amplifier are mixed down to dc and then low pass filtered. The ADC conversion is done after passing the signal by or through an ADC-buffer amplifier. The expected ADC values can be calculated by the following formula⁶:

$$RainSignalADC value = \frac{I_{PDrain}*R_{TIA}*K_{DEMOD}*GAIN_ADJ_AA*K_{SC-LPF}*GAIN_BUF}{50,3\frac{\mu V}{LSB}} + 2^{15}$$

with $R_{TIA} = 10k$; $K_{DEMOD} = 0.5$ (for best setting of *tdem* in SetAna Register); $K_{SCLPF} = 2$; $K_{SCLPF} = 2$;

The input amplifiers of the rain channels are able to bias the external photodiodes with dc photocurrent up to 900uA. A number of parameters of the rain sensor frontend can be influenced by user register settings (by means of the μ Controller over the SPI interface) in order to optimize the device to the individual application conditions:

- 1) Carrier Frequency of transmitted rain measurement signal (see chapter 7.4.6)
- 2) Number of Pulses of rain measurement transmission burst (see chapter 7.4.6)
- 3) Delay time for demodulation of burst signals (see chapter 7.4.1)
- 4) Bandwidth and Gain adjust of AA-Filters of both channels (see chapters 7.4.3 and 7.4.5)
- 5) Bandwidth adjust of LP Filters (see chapters 7.4.3 and 7.4.5)
- 6) Gain of the ADC buffer amplifier (see chapter 7.4.10)

7.1.1.1 Rain Channel DC Light measurement

The input dc current compensation circuitry of the transimpedance amplifier is able to supply and measure the DC current supplied to the photodetector. Both rain channels are identical in structure. In order to reach a feasible resolution in the current range of interest (low currents in the range up to 275uA), the measurement

3901075308 Page 15 of 72 Rev 002

⁶ The demodulator gain of 0.5 is only valid for the best setting of the demodulator delay time "tdem". The optimum value is different for each application and can be modified by means of the SetAna register.

Rain-/Light-Sensor IC for Automotive

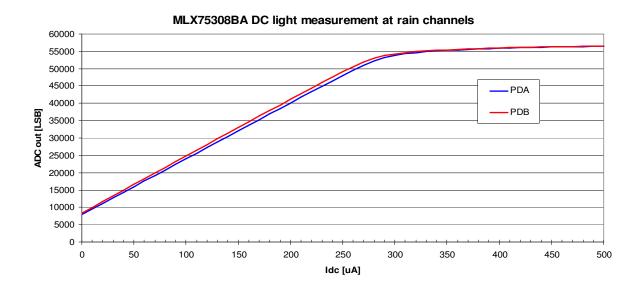


Figure 1: Typical Rain Channel DC measurement characteristics for both channels A and B for different sensitivity trimming options.

Characteristics will saturate for currents above the I_{DC} current range, however the compensation circuit is nevertheless able to supply the specified current levels up to 900uA to the detector. The given ADC word length for the rain channel dc light data is 16Bit.

7.1.2 Rain Channel DC Light compensation

The variation of the rain signals as a function of DC-light can be partially compensated by automatically adapting the amplitude of the sensors' transmitted infrared light pulses for rain measurement.

In order to make the system as flexible as possible, the compensation can be adapted to different photodiode types by definition of the compensation characteristics as a piecewise linear curve like described in Figure 2. The values of the 5 corner points of the curve can be defined by the corresponding 4-Bit words $PD_COMP_ICx<3:0> (x = 1..5)$ in the register maps, see chapter 7.4.9. The PD light compensation can be enabled by setting the EN PDCOMP bit to "1".

In order to calculate the decimal values PD_COMP_ICx<3:0> (x = 1..5) for a certain photodiode, one has to measure the relative rain pulse levels p_x at 5 different DC light levels I_{amb_x} in case the EN_PDCOMP is set to "0" (a calculation example is given below):

$$\begin{split} & p_0 = \text{pulse level at } (I_{amb_0} = 0) = 1 \text{ (this is the 100\% reference)} \\ & p_1 = \text{pulse level at } (I_{amb_1} = 10\text{uA}) = \text{e.g. } 0.97440 = \frac{ADCRain@Iamb_0 - 2^{15}}{ADCRain@Iamb_1 - 2^{15}} \\ & p_2 = \text{pulse level at } (I_{amb_2} = 45\text{uA}) = \text{e.g. } 0.94224 = \frac{ADCRain@Iamb_0 - 2^{15}}{ADCRain@Iamb_0 - 2^{15}} \\ & p_3 = \text{pulse level at } (I_{amb_3} = 150\text{uA}) = \text{e.g. } 0.91556 = \dots \\ & p_4 = \text{pulse level at } (I_{amb_4} = 500\text{uA}) = \text{e.g. } 0.89858 = \dots \\ & p_5 = \text{pulse level at } (I_{amb_5} = 900\text{uA}) = \text{e.g. } 0.89477 = \dots \end{split}$$



Rain-/Light-Sensor IC for Automotive

Based on these relative rain pulse levels, one can calculate the following parameters (x = 1..5):

$$r_{comp_i} = 3 \cdot 10^{-5} (1 - p_x)$$

Y _{comp 1}		1.285714	-0.28571	0	0	0		r _{comp 1}	
y _{comp 2}		-1.28571	1.714286	-0.42857	-1.8E-17	1.78E-17		r _{comp 2}	
y _{comp 3}	=	0	-1.42857	1.857143	-0.42857	-7.9E-17	•	r _{comp 3}	
Y _{comp 4}		0	0	-1.42857	2.678571	-1.25		r _{comp 4}	
Y _{comp} 5		0	0	0	-2.25	2.25		r _{comp 5}	

For the calculation example, we get the following values:

The settings PD_COMP_ICx<3:0> (x = 1..5) can be derived from the y_{comp_x} (x = 1..5) as follows:

PD_COMP_IC1[3:0] = round (
$$\frac{y_{comp_1}}{0.4 \times 0.132 \ 10^{-6}}$$
, 0)

PD_COMP_IC2[3:0] = round (
$$\frac{y_{comp_{-}2}}{0.4 \times 0.165 \ 10^{-6}}$$
 , 0)

PD_COMP_IC3[3:0] = round (
$$\frac{y_{comp_3}}{0.4 \times 0.334 \ 10^{-6}}$$
 , 0)

PD_COMP_IC4[3:0] = round (
$$\frac{y_{comp_{-}4}}{0.4 \times 0.334 \ 10^{-6}}$$
 , 0)

PD_COMP_IC5[3:0] = round (
$$\frac{y_{comp_5}}{0.4 \times 0.180 \ 10^{-6}}$$
, 0)

For the calculation example, this means:

PD_COMP_IC1[3:0] = 9dec PD_COMP_IC2[3:0] = 14dec

PD_COMP_IC3[3:0] = 7dec PD_COMP_IC4[3:0] = 5dec

PD_COMP_IC5[3:0] = 3dec

These values can be written inside the corresponding registers, see chapter 7.4.9. When the PD compensation is enabled (EN PDCOMP = "1"), the compensation will modulate the LED current of the rain channels.

Rain-/Light-Sensor IC for Automotive



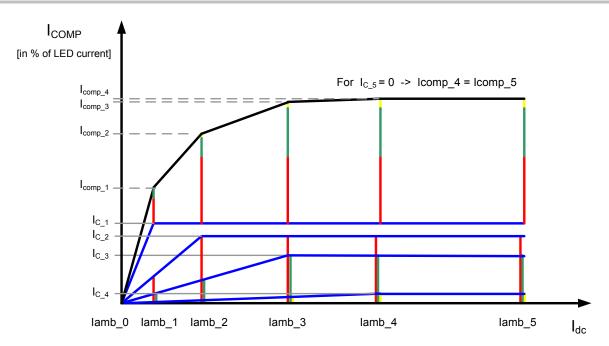


Figure 2: Example of a compensation curve I_{COMP} for $I_{C_{.5}}=0$. The dc-currents of the corner points are fixed in the design and cannot be influenced. The compensation components $I_{C_{.1}}...I_{C_{.5}}$ are defined by the registers DC_COMP_IC1...5 with 4bits each. The resulting compensation characteristics are shown in the black graph.

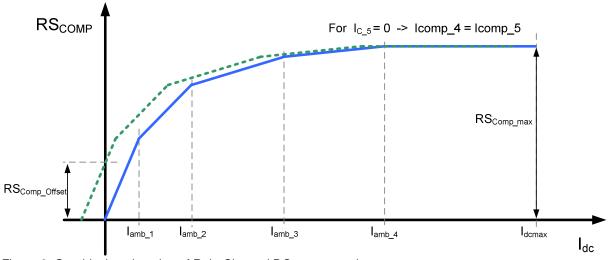


Figure 3: Graphical explanation of Rain-Channel DC compensation parameters

7.1.3 LPF- Low Pass Anti-aliasing Filter

This filter acts as an anti-aliasing filter in front of the switched-capacitor lowpass filter. In order to limit the LED output power range to be covered, the LPF gain is switchable. The gainmode selection and the -3dB corner frequency is user controlled by means of SPI via registers SetAL (GAIN_ADJ_AA_A<2:0>) and SetBL (GAIN_ADJ_AA_B<2:0>).



Rain-/Light-Sensor IC for Automotive

7.1.4 S-C biquad Low-pass filter

The Low pass filter limits the cut-off frequency of the receiver system. This leads to improved sensitivity for the wanted signals. Furthermore, out of band interferers are attenuated. The low pass filter cut-off frequency can be controlled by the register SetAL(BW_SEL_LP_A<1:0>) and SetB (BW_SEL_LP_B<1:0>).

7.1.5 Ambient Light Sensor

7.1.5.1 Normal operation

The ambient light detection system of the MLX75308 consists of three independent channels C, D and E and an on-chip controllable dedicated ground pin GNDAMB. GNDAMB is internally set to GNDA in normal operation. An external photodiode is connected in between each channel and GNDAMB. The ambient light signal is low pass filtered on chip.

The signal of a 1ms switched-capacitor filters is sampled by the ADC (on request by an SPI command, each 2.5ms), where it is converted into a 16bit digital word.

The total input stage, this means from the external diode up to the 1ms filter, has a cut-off frequency at ~160Hz. Sampling this output every 2.5ms, commanded by SPI, would make a sample rate of 400Hz, which is well above the Nyquist frequency of the present frequency content of 160Hz.

Within the specified input current range the ambient input stages bias the external photodiodes with > 0V in normal operation.

7.1.5.2 (Ambient light) Buffer autozeroing

To eliminate buffering errors inside the ambient channels, the buffers that read from the bipolar inputs are self-compensating their offset. This happens through an autozeroing mechanism in which the error of the buffer is first sampled on a capacitor and afterwards subtracted from the output of the buffer.

This error compensation degrades over time, which means it has to be updated on a regular basis. The update rate at which this happens is given by the Tamb register.

During this autozeroing, reading out from the ambient channels or temperature sensor is always possible. No special actions should be taken by the user.

The autozeroing timer is not the only sequence that activates an autozeroing phase on the ambient channels. Autozeroing is also automatically done inside the sequence of readout of an ambient channel, of the temperature sensor, after firing the rain channel LED's or after an ambient diagnostics command. Doing this will always set the autozeroing timer back to its initial counting value.

This means that when the ambient channels are read out on a regular basis of 2.5ms and the ambient timer value Tamb<1:0> is set to 2'b10 (5ms), the timer is always reset before it is used. In this situation the read out rate of the ambient channels is sufficient for updating the error compensation of the buffers.

Rain-/Light-Sensor IC for Automotive

7.1.5.3 Calibration and temperature compensation

The output of each ambient channel has a strong temperature dependence and a slight process dependence that can be compensated at run time. This is shown in following equation (channel x, x = C, D or E):

$$I_{x} = \left(1 + TC_{lref} \Delta T\right) \left(1 + \alpha \frac{O_{x}}{300^{2}} \Delta T\right) e^{\alpha \left(\frac{ambout_{x} - 2^{15}}{T}\right) + \beta}$$
(1)

calculated input light value

16-bit ADC converted value of the ambient channel

ambout_x: TC_{Iref}: temperature coefficient of the reference current (typ. Value = +375ppm/K)

offset of the measurement (digital value) calibration values for channel x (see below)

During calibration at least 2 light levels (I_{x1} and I_{x2}) have to be supplied to the target ambient channel (x) with its photodiode at the same known temperature T. The closer these values are chosen to the range used in application, the more accurate the final result. During the setting of these light levels, the output of ambient channel x: ambout_{x1} and ambout_{x2} are measured. This results in 2 equations and 2 unknowns: α_x and β_x . Both unknowns can be calculated from following formulas:

$$\alpha = \frac{T \ln \left(\frac{I_1}{I_2}\right)}{ambout_1 - ambout_2} \quad \text{and} \quad \beta = \ln \left(\frac{I_1}{1}\right) - \alpha \left(\frac{ambout_1 - 2^{15}}{T}\right) \quad (2)$$

Note that these 2 values automatically correct any gain error of the connected photodiode and used lens system.

7.1.5.4 Response time

During operation, each ambient channel constantly shows a logarithmic output response towards the input current that is applied. As a result, the time for the output to respond on a changing input current is defined by a strongly non-linear function (similar but not equal to an RC-curve). Therefore a threshold crossing criterion is used to define the time response.

The light threshold level is defined as a border between light and dark. This threshold can be defined as a light level of a voltage level at the output of the ambient light channel. If the light suddenly crosses the defined light threshold, the output of the ambient light channel will cross the corresponding voltage threshold with a delay. This delay is the response time.

Figure 4 shows an example of such a threshold crossing. An input current step is used as this represents the worst case condition. Note that starting from an input current level that is close to the threshold, the end requirement of 20% below or 80% above can be heavily relaxed.

The ambient light response time is valid for any threshold level equal to or above the defined input threshold level I_{ambx detect} of any input channel.

Rain-/Light-Sensor IC for Automotive

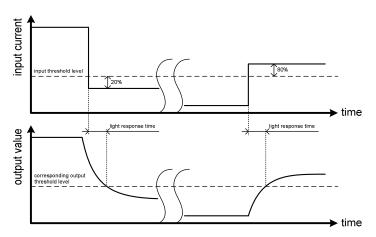


Figure 4: Ambient response time explanation

7.1.5.5 Diagnostics mode operation

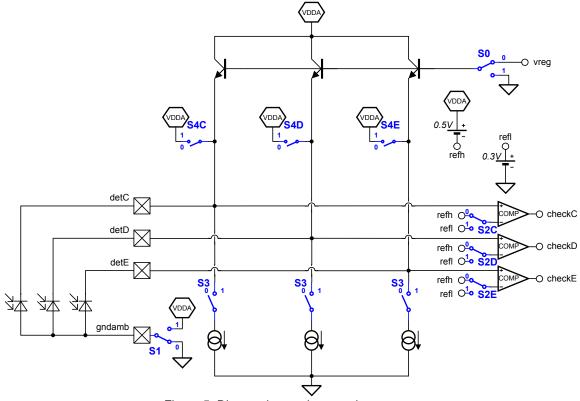


Figure 5: Diagnostics mode operation structure.

In diagnostics mode, the status of the external photodiodes is checked. In this mode, the Ambient Regulator switches the voltage on the base of the bipolar structures to ground, hereby disconnecting them from the ambient inputs (S0).



Rain-/Light-Sensor IC for Automotive

A set of switches (S1..S4) then controls the different possible error conditions by running through the different tests. At the end of this check, all switches go back into the initial position to allow normal ambient light detection.

Table 10 lists the possible error modes for detector C and pin GNDAMB. The error modes for detectors D and E are equivalent.

Failure	Detected	How
detC disconnected	diagnostics	 GNDAMB pulled to VDDA (S1=1) Pull current from detC to GNDA (S3x=1) Set comparator C to low reference (S2C=1) If checkC == 0: error!
GNDAMB disconnected	diagnostics	Identical test as detC disconnected.
detC shorted to GNDA/GNDD/GNDAMB	normal mode	Ambient detector shows incredible high light input ADC response is much likely saturated, anyway the output is far beyond the allowed operation range.
	Diagnostics	 GNDAMB kept to GNDA (S1=0) DetC is briefly (10µs) pulled to VCCA – current between 15mA and 50mA (S4C=1) Set comparator C to high reference (S2C=0) If checkC == 0: error!
detC shorted to VCCA/VCCD	diagnostics	 GNDAMB kept to GNDA (S1=0) Pull current from detC to GNDA (S3x=1) Set comparator C to low reference (S2C=1) If checkC == 1: error!
GNDAMB shorted to GNDA/GNDD	various	 This is no problem for normal operation. This CAN be a problem in testmode if short is strong and pin GNDAMB pulled to VDDA: a maximum current of 50mA can be pulled during 10µs. If so, test for detC disconnected will show an error.
GNDAMB shorted to VCCA/VCCD	normal mode Diagnostics	A maximum current of 800mA can be pulled from this driver. If the current can be supplied by the module, an error will be flagged similar to detC shorted to VCCA/VCCD.
detC shorted to detD (or detE)	diagnostics	 GNDAMB kept to GNDA (S1=0) Pull detC to VCCA (S4C=1) Pull current from detD to GNDA (S3x=1) Comparator C set to high reference (S2C=0) Comparator D set to low reference (S2D=1) If checkC == 0: error! If checkD == 1: error!

Table 10: List of possible failures on the ambient pins – projected on channel C.

Note that in spite of the ability to detect any error by the ambient diagnostics, an error on an ambient pin might still have other unwanted effects.

- Shorting any channel to GNDA/GNDD/GNDAMB will make the readout of the whole ambient block useless. At this time a maximum current of 14mA might be constantly pulled from the supply, independent of the amount of channels that are shorted to GNDA/GNDD/GNDAMB.
- During normal operation, node GNDAMB should be considered a ground pin. Shorting this pin to any other voltage might result in a shortcurrent of max 800mA!
- Because of such unwanted effects, a detection of an error in diagnostics mode should be followed by a disabling of the ambient channels in order to avoid disturbing the operation of other blocks in the system.

Rain-/Light-Sensor IC for Automotive

 Note that unused channels should be connected with an external resistance (~60kOhm) to GNDAMB. Doing so will avoid disturbing the other channels, but will give a constant error on the channel connected to GNDAMB.

7.1.6 Temperature Sensor

The on-chip temperature sensor measures the IC temperature. The output voltage of the sensor is converted by the 16-bit ADC. The sensor will be trimmed during production for the best result. This trimming value is not applied to the temperature sensor internally, but is available to the customer through two on-chip registers Calib1 and Calib2, see 7.4.11. The Calib1 register contains the slope of the temperature curve in LSB/K. The Calib2 register contains the offset of the curve at a defined temperature at which the chip is tested in production.

At temperatures above 85 °C, the uC is required to inhibit the LED drive because they may be irreversibly damaged by operation above this temperature. An example plot for the temperature sensor is given in Figure 6.

MLX75308BA temperatures [deg.C] vs. ADC out of temperature sensor (slope and offset depends on Calib1 and Calib2)

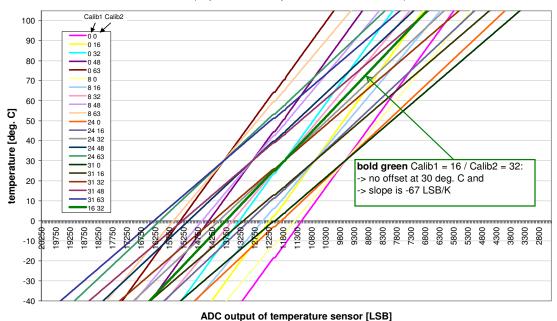


Figure 6: Temperature sensor example graph.

The temperature is calculated from the temperature readout (*tempout*) and the gain and offset calibration data (calibration data measured at 30 °C) according to the formula:

$$T_K = 303.15K + \frac{(11775 + 67(calib2 - 32)) - tempout}{67 + (calib1 - 16)}$$
 K

Rain-/Light-Sensor IC for Automotive

or in °C:

$$T = 30^{\circ}\text{C} + \frac{(11775 + 67 (calib2 - 32)) - tempout}{67 + (calib1 - 16)} ^{\circ}\text{C}$$

tempout: digital temperature readout (16Bit) calib1: contents of calib1 register (5Bit) contents of calib2 register (6Bit)

7.1.7 DAC

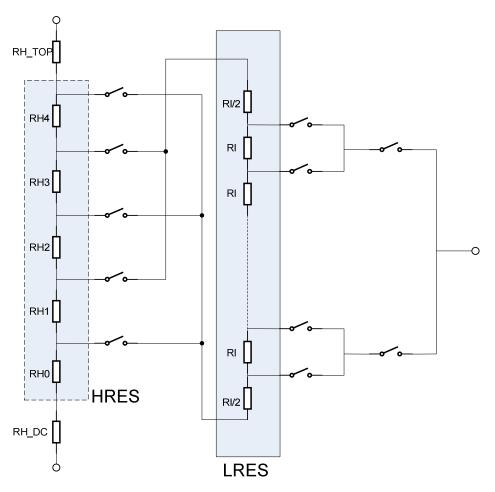


Figure 7: DAC structure

Block description

For this specific MLX75308 rain light sensor application, the DAC has been designed to have the following features:

To generate a pulse voltage signal from 1mV to 1V, so that LED current driven by LED driver can be 1mA to 1A if a 1Ω shunt resistor is used between pins 18 and 19.



Rain-/Light-Sensor IC for Automotive

Because of the logarithmic feature of step changes on photodiode due to different glass, a logarithmic feature is also asked for the DAC to compensate that. To make a real logarithmic DAC will be difficult for design, instead, a piece wise linear DAC with four zones is implemented.

The low level of pulse voltage signal should be 1mV to make sure that the Operational Amplifier in the LED Driver can operate well.

The structure of DAC is designed as shown in Figure 7. Two resistor strings are used: the lower ohmic resistor string HRES is connected between node GND and VCC, the DC voltage level of pulse signal (pulse low level 1mV) is generated over resistor RH_DC. The resistors RH0 – RH4 are arranged to have a logarithmic value from bottom up. By switching between HRES and LRES, which are controlled by DAC 2 MSBs (B[7:6]), the high ohmic resistor string can be connected over one of resistors RH0 –RH4. Together with the switches at right side, which are controlled by DAC 6 LSBs (B[7:6]), the desired DAC output voltages are generated.

DAC piece (2MSBs B[7:6])	Steps each piece (6LSBs B[5:0])	step size for 1 bit (V)	Range covered (V)	Range start (V)	Range end (V)
00	64	1.00E-04	6.40E-03	1.05E-03	7.35E-03
01	64	5.00E-04	3.20E-02	7.65E-03	3.92E-02
10	64	2.50E-03	1.60E-01	4.07E-02	1.98E-01
11	64	1.25E-02	8.00E-01	2.06E-01	9.93E-01

Table 11: The DAC voltage values based DAC codes (B[7:6])

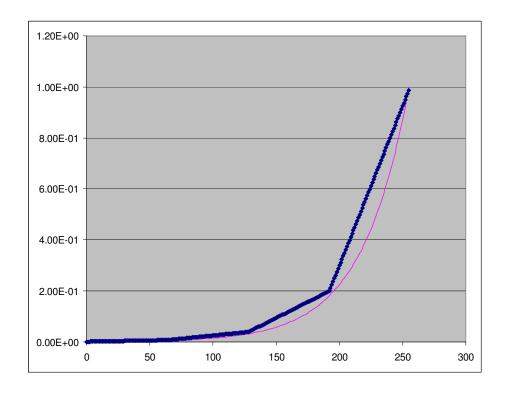


Figure 8: Piece Wise Linear DAC voltage VS DAC codes (in blue, pink is ideal logarithmic curve)



Rain-/Light-Sensor IC for Automotive

After controlling and slewing circuitry, the following voltage curve is generated, which is used as input of LED driver. The final output voltage over external shunt resistor is as shown in Figure 9

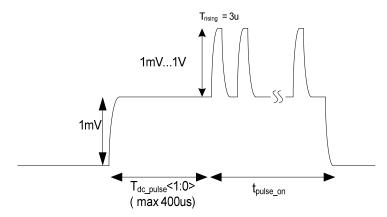


Figure 9: Vshunt waveform

Rain-/Light-Sensor IC for Automotive

7.1.8 LED Driver

Block descriptions

The working principle the LED driver is; the opamp drives the gate terminal of an external MOSFET, through a voltage follower stage; the voltage on top of a shunt resistor is sensed and fed back to the negative input of opamp to make a closed loop control system. As the bottom side of Rshunt is connected to external gnd on PCB, the external disturbance on PCB when firing LED burst might also influence the accuracy of current settings. To eliminate this effect, the difference voltage of external gnd point and internal ref point is also sensed and fed back to opamp, and also by regulating gate terminal of external MOSFET. In this way, the voltage across Rshunt will always be regulated to the same value as the difference of DAC and ref point.

7.1.9 POR

The Power On Reset (POR) is connected to voltage supply.

The POR cell generates a reset signal (high level) before the supply voltage exceeds a level from 2.7V. The cell contains a hysteresis of 100mV.

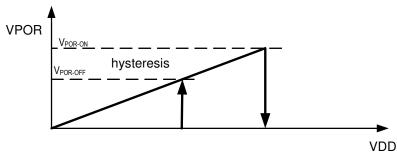


Figure 10: POR sequence

7.2 SPI

7.2.1 General description of SPI interface

After power-on, the sensor enters a reset state (invoked by the internal power-on-reset circuit). A start-up time t_{startup} after power-on, the internal reference voltages have become stable and a first measurement cycle can start. To indicate that the start-up phase is complete, the *DR* pin will go high (*DR* is low during the start-up phase).

The control of this sensor is completely SPI driven. For each task to be executed, the proper command must be uploaded via the SPI. The SPI uses a four-wire communication protocol. The following pins are used:

- **CS**: when CS pin is low, transmission and reception are enabled and the MISO pin is driven. When the CS pin goes high, the MISO pin is no longer driven and becomes a floating output. This makes it possible that one micro-processor takes control over multiple sensors by setting the CS pin of the appropriate sensor low while sending commands. The idle state of the chip select is high.
- **SCLK:** clock input for the sensor. The clock input must be running only during the upload of a new command or during a read-out cycle. The idle state of the clock input is high.
- **MOSI**: data input for uploading the different commands and the data that needs to be written into some registers. The idle state of the data input is low.



Rain-/Light-Sensor IC for Automotive

• MISO: data output of the sensor.

A SPI timing diagram is given in Figure 11. This is the general format for sending a command. First the *CS* pin must be set low so that the sensor can accept data. The low level on the *CS* pin in combination with the first rising clock edge is used to start an internal synchronization counter that counts the incoming bits. Data on the *MOSI* pin is clocked in at the rising clock edge. Data on the *MISO* pin is shifted out during the falling clock edge. Note that the tri-state of the *MISO* pin is controlled by the state of *CS*.

After uploading a command, the *CS* pin must be set high for a minimum time of t_{cs_inter} in order to reset the internal synchronization counter and to allow new commands to be interpreted.

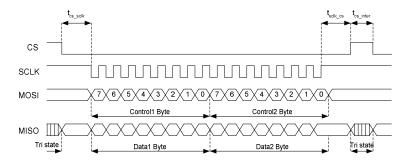


Figure 11: SPI Timing Diagram for 2 byte instructions

The basic structure of a command consists of 2 bytes: the Control1 Byte and the Control2 Byte that are uploaded to the device and the Data1 Byte and the Data2 Byte that are downloaded to the micro-controller. Exceptions are the commands needed to read and write the user registers (WR/RR). These commands need 3 bytes. The timing diagram is given in Figure 12.

All data transfer happens with MSB first, LSB last. Referring to Figure 11 and Figure 12: within a byte, bit 7 is always defined as the MSB, bit 0 is the LSB. This applies to all data transfers from master to slave and vice versa.

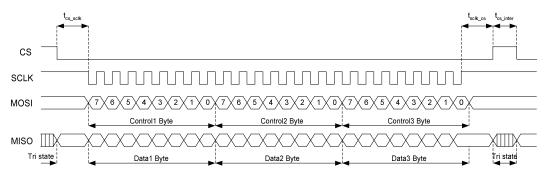


Figure 12: SPI Timing Diagram for 3 byte instructions

The MSB of the Control1 Byte (bit 7) is a command token: setting this bit to 1 means that the Control1 Byte will be interpreted as a new command. If the MSB is 0, the next bits are ignored and no command will be accepted. The idle command has a Control1 Byte of 0x00.

The command type (chip reset, power mode change, start measurements, start read-out, read/write register) is selected with the next bits 6..0 of the Control1 Byte.

The Control2 Byte consists of 0x00, to allow clocking out the Data2 Byte. The Data2 Byte contains always the Ctrl1 Byte that was uploaded. Thus the micro-controller can check that the Data2 Byte is an exact replica of the Ctrl1 Byte, to verify that the right command is uploaded to the device.

The Data1 Byte contains some internal status flags to allow checking the internal state of the device.



Rain-/Light-Sensor IC for Automotive

The internal status flags are defined in the table below. See section 7.3 for more information concerning the operation of the status flags.

Status flag	Status when bit is set	Status when bit is clear
Bit 7 (MSB)	Previous Command was invalid	Previous Command was valid
Bit 65	Power State: 11 = (reserved) 10 = Normal Running Mode 01 = Stand-by State 00 = Sleep State	
Bit 4	Sleep Request was sent	No Sleep Request available
Bit 3	Standby Request was sent	No Standby Request available
Bit 2	Device is in TestMode	Device is not in TestMode
Bit 1	Internal Oscillator is enabled (Standby Mode or Normal Running Mode)	Internal Oscillator is shut down (Sleep Mode)
Bit 0 (LSB)	Critical Error occurred	No Error is detected

Table 12: Internal Status Flags as given in the Data1 Byte

Table 13 summarizes the instruction set of the sensor. A detailed explanation of these different commands is given in Section 7.2.2.



Rain-/Light-Sensor IC for Automotive

Symbol	Command Description	Control1 Byte	Control2 Byte	Control3 Byte
NOP	Idle Command	0000 0000	0000 0000	N/A
CR	Chip Reset	1111 0000	0000 0000	N/A
RSLP	Request Sleep	1110 0001	0000 0000	N/A
CSLP	Confirm Sleep	1010 0011	0000 0000	N/A
RSTBY	Request Standby	1110 0010	0000 0000	N/A
CSTBY	Confirm Standby	1010 0110	0000 0000	N/A
NRM	Normal Running Mode	1110 0100	0000 0000	N/A
SM	Start Measurement	1101 R ₂ R ₁ R ₀ T	$M_6M_3 M_2M_1M_0P$	N/A
SD	Start Diagnostics	1011 0000	$M_6M_3 M_2M_1M_0P$	N/A
RO	Start Read-Out	1100 0011	0000 0000	N/A
WR	Write Register	1000 0111	D ₇ D ₀	A ₃ A ₀ P ₁ P ₀ 00
RR	Read Register	1000 1110	A ₃ A ₀ 0000	0000 0000

Table 13: Instruction set of the rain light sensor

Besides the above instruction set, there are some test commands available for production test purposes. To prevent unintentional access into these test modes, it requires multiple commands before the actual test mode is entered.

An overview of modes in which the device can operate is shown in Figure 13 below. It is also indicates which commands are available in the different operation modes.

Rain-/Light-Sensor IC for Automotive

State Diagram MLX75308BA

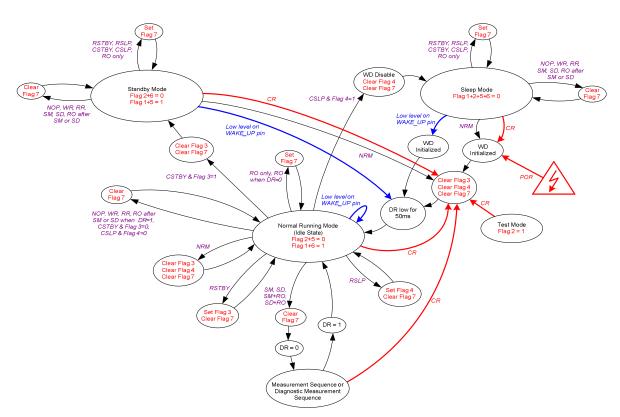


Figure 13: State Diagram of the MLX75308



Rain-/Light-Sensor IC for Automotive

7.2.2 Detailed explanation of SPI Instruction Words

7.2.2.1 NOP - Idle Command

The Idle Command can be used to read back the internal status flags that appear in the Data1 Byte. The state of the device is not changed after the NOP command is uploaded.

7.2.2.2 CR - Chip Reset Command

After upload of a Chip Reset command, the sensor returns to a state as it is after power-up (Normal Running Mode) except for the watchdog counter, the state of the *MR* line and the contents of the 'Rst' register. The watchdog counter, the 'Rst' register and the state of the *MR* line will not be influenced by a CR command.

The CR command can be uploaded at any time, even during a measurement or a read-out cycle, provided that the internal synchronization counter is reset. This is done by setting the CS pin high for at least a time $t_{cs\ inter}$.

When a CR command is uploaded during sleep mode resp. standby mode, the device goes automatically into normal running mode. Note that this requires a time t_{wakeup_slp} resp. t_{wakeup_stby} before the internal analog circuitry is fully set up again.

Right after upload of a CR command, the DR pin will go low during a time t_{startup} . Once the wake-up/reset phase is complete, the DR pin will go high.

7.2.2.3 RSLP/CSLP - Request Sleep/Confirm Sleep

To avoid that the slave device goes unintentionally into sleep mode, the master has to upload two commands. First a RSLP (Request Sleep) shall be uploaded, then the slave sets bit 4 of the internal status flag byte high. The master has to confirm the sleep request by uploading a CSLP (Confirm Sleep). Afterwards the slave will go into Sleep Mode, hereby reducing the current consumption.

The status flag can be cleared by uploading a CR command or a NRM command. Note that uploading a Chip Reset makes the device switch into normal running mode.

When the device is operating in Sleep Mode, the *WAKE_UP* pin will be monitored. A falling edge on *WAKE_UP* will wake up the device and will switch it into Normal Running Mode.

When the device is operating in Sleep Mode, the *WT* pin will be monitored. If a falling edge is detected, the Critical Error flag in the Internal Status Flag Byte will be set high and the corresponding bit in the 'Err' register will be set high (refer also to Sections 7.3 and 7.4.7).

Note that no pull-up or pull-down resistor is foreseen on the $WAKE_UP$ pin. To avoid that parasitic spikes can wake up the device, the $WAKE_UP$ input is debounced (typical debounce time is in the range of $2\mu s$). The low time on the $WAKE_UP$ pin should be at least a time t_{wu} .

The state of the DR pin will not be changed when going into Sleep Mode. However, after a wake-up event the DR pin is set low during a time t_{wakeup slp}.



Rain-/Light-Sensor IC for Automotive

7.2.2.4 RSTBY/CSTBY - Request Standby/Confirm Standby

To put the device in Standby Mode, a similar system is used: the master shall send the RSTBY command, requesting the slave to go into Standby Mode. The slave device sets bit 3 of the internal status flag byte high, indicating that it wants to go into standby. The master has to confirm this by sending the CSTBY byte.

The status flag can be cleared by uploading a CR command or a NRM command. Uploading a Chip Reset makes the device switching into normal running mode.

When the device is operating in Standby Mode, the *WAKE_UP* pin will be monitored. A falling edge on *WAKE_UP* will wake up the device and will switch it into Normal Running Mode.

Note that no pull-up or pull-down resistor is foreseen on the $WAKE_UP$ pin. To avoid that parasitic spikes can wake up the device, the $WAKE_UP$ input is debounced (typical debounce time is in the range of $2\mu s$). The low time on the $WAKE_UP$ pin should be at least a time t_{wu} .

The state of the DR pin will not be changed when going into Standby Mode. However, after a wake-up event the DR pin is set low during a time t_{wakeup_stby} .

7.2.2.5 NRM – Normal Running Mode

The NRM command shall be used to wake up the device from Sleep Mode, or to go from Standby into Normal Running Mode. This requires a time t_{wakeup_slp} resp. t_{wakeup_stby} before the internal analog circuitry is fully set up again. The NRM will also clear the Sleep Request or Standby Request flag.

When the NRM command is uploaded during normal running mode, the state of the device will not be influenced, except when the Sleep Request or Standby Request flag was set high due to a RSLP or RSTBY command. In this case, the Sleep Request or Standby Request flag will be cleared; the state of the DR pin will not change.

7.2.2.6 SM - Start Measurement

The SM command is used to start up measurement cycles. Several types of measurements can be selected with the measurement selection bits $M_6..M_0$ in the Control2 Byte:

- M₆: setting this bit high enables the temperature measurement
- M₅: setting this bit high enables the read-out of the three ambient light channels
- M₄: setting this bit high enables the DC light measurement in the rain channel(s)
- M₃: setting this bit high fires LED A
- M₂: setting this bit high fires LED B
- M₁: setting this bit high enables the rain measurement in channel A
- M₀: setting this bit high enables the rain measurement in channel B

A typical timing diagram is given in Figure 14. After uploading the SM command, the measurement cycle is started as soon as the *CS* pin is set high. The ADC starts converting all the needed analog voltages and stores the digital values in registers.

A time t_{cs_dr} after CS is set high, the state of the DR pin goes low. A time t_{dr} after DR was set low, the state of the DR pin becomes high, indicating that all measurements are completed and that the resulted data is available for read-out (read-back of the stored data in the registers). This time can be up to 231.84us, if an internal autozeroing process is under execution and needs to be finished.

Table 14 gives an overview of some execution times t_{dr} for the basic types of measurements.

Rain-/Light-Sensor IC for Automotive

Measurement Type	Min. t _{dr} (μs)	Max. t _{dr} (μs)
Temperature measurement	269	298
Ambient light measurements on all channels C, D & E	388	430
Rain measurements on channels A & B, with 32 pulses, pulse frequency of 48.1kHz, Tdem=6us, Tdc_pulse=400us	1513	1673
DC + Rain measurements on channels A & B, with 32 pulses, pulse frequency of 48.1kHz, Tdem=6us, Tdc_pulse=400us	1811	2002
Temperature measurement + Ambient light measurements on all channels C, D & E + DC + Rain measurements on channels A & B, with 32 pulses, pulse frequency of 48.1kHz, Tdem=6us, Tdc_pulse=400us	2079	2299

Table 14: Basic Measurement Execution Times t_{dr}

Note that the DR pin can be used as an interrupt for the master device as it indicates when a read-out cycle can be started.

<u>Note</u> that measurement execution of Rain measurement only is not allowed. Rain measurements must always be done with Ambient Light measurements.

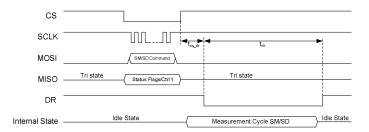


Figure 14: Timing Diagram of a Measurement Cycle

The SM command contains 3 option bits $R_2R_1R_0$. These bits set the polarity of the anti-aliasing filters, the switched capacitors low pass filters and the ADC input buffer in rain channels A & B:

- R2: this bit inverts the op-amp in the anti-aliasing filter. The output will change from (Signal + Offset_opamp_aa) to (Signal offset_opamp_aa). In this way, by processing 2 measurements with inverted R2 bits, the offset of the AA filter can be cancelled.
- R1: Inversion of the offset of rain_sclp_filter. The output will change from (Signal + Offset_opamp_sclp) to (Signal offset_opamp_sclp). In this way, by processing 2 measurements with inverted R1 bits, the offset of the SCLP filter can be cancelled.
- R0: Inversion of the offset of the ADC_buffer. The output will change from (Signal + Offset_opamp_buf) to (Signal offset_opamp_buf). In this way, by processing 2 measurements with inverted R0 bits, the offset of the SCLP filter can be cancelled.
- T: this bit replaces the light pulses by internal current pulses during the rain measurements.

Rain-/Light-Sensor IC for Automotive

The SM command contains an option bit T. If this bit is set to 0, normal rain measurements are performed (i.e. the external LEDs are fired and the rain channels A and/or B are measured). If this bit is set to 1, no LEDs are fired, but internal test pulses are applied to channels A and/or B. The internal testpulses can be influenced in amplitude by the bits DACA7 and DACA6. Limits for ADC outputs of the TIA testpulses are shown in Table 4.

DACA7	DACA6	I_Testpulse [uA]
0	0	5
0	1	13
1	0	21
1	1	29

Table 15: Current levels for Rain testmode.

In the Control2 byte an even parity bit P is foreseen. The parity bit calculation is based on the measurement selection bits $M_6..M_0$. If the number of ones in the given data set $[M_6..M_0]$ is odd, the even parity bit P shall be set to 1, making the total number of ones in the set $[M_6..M_0, P]$ even.

The SPI invalid flag will be set when the parity bit does not correspond to the calculated parity bit.

After upload of a SM/SD command, no other commands will be accepted till *DR* is high. This is done to avoid too many disturbances in the analog part. Once *DR* is high, the next command will be accepted. An exception however is the Chip Reset command. This will always be accepted.

Note that none of the SM/SD commands are available in Standby Mode.

7.2.2.7 RO - Start Read-Out

When the state of the *DR* pin changed into a high state, the measurement data is available for read-out. The RO command shall be uploaded to start a read-out cycle and to start reading out the data that was stored in the internal registers.

To make sure that no memory effects can occur, all data registers are cleared at the end of each read-out cycle.

A typical timing diagram is given in Figure 15 below:

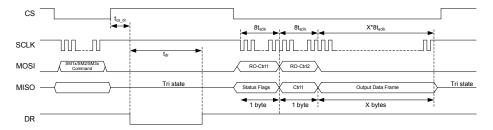


Figure 15: Timing diagram for Read-Out

The data that appears on the MISO pin depends on the type of measurement that was done (i.e. it depends on the command that was uploaded: SM/SD and the selected measurement bits $M_6..M_0$).



Rain-/Light-Sensor IC for Automotive

The table below shows the Output Data Frame when all measurements are selected:

Data Byte Number	Output Data Frame Contents	Comments
Byte 3	Temperature (8 MSB)	Depends on M ₆
Byte 4	Temperature (8 LSB)	Depends on M ₆
Byte 5	Ambient light channel C measurement (8 MSB)	Depends on M₅ + on EN_CH_C
Byte 6	Ambient light channel C measurement (8 LSB)	Depends on M₅ + on EN_CH_C
Byte 7	Ambient light channel D measurement (8 MSB)	Depends on M₅ + on EN_CH_D
Byte 8	Ambient light channel D measurement (8 LSB)	Depends on M₅ + on EN_CH_D
Byte 9	Ambient light channel E measurement (8 MSB)	Depends on M₅ + on EN_CH_E
Byte 10	Ambient light channel E measurement (8 LSB)	Depends on M₅ + on EN_CH_E
Byte 11	DC measurement of IR channel A, before the Rain burst measurement (8 MSB)	Depends on M ₄
Byte 12	DC measurement of IR channel A, before the Rain burst measurement (8 LSB)	Depends on M ₄
Byte 13	DC measurement of IR channel B, before the Rain burst measurement (8 MSB)	Depends on M ₄
Byte 14	DC measurement of IR channel B, before the Rain burst measurement (8 LSB)	Depends on M ₄
Byte 15	Rain burst measurement of IR channel A (8 MSB)	Depends on M ₁ + LED selection depends on M ₃ /M ₂
Byte 16	Rain burst measurement of IR channel A (8 LSB)	Depends on M ₁ + LED selection depends on M ₃ /M ₂
Byte 17	Rain burst measurement of IR channel B (8 MSB)	Depends on M ₀ + LED selection depends on M ₃ /M ₂
Byte 18	Rain burst measurement of IR channel B (8 LSB)	Depends on M ₀ + LED selection depends on M ₃ /M ₂
Byte 19	DC measurement of IR channel A, after the Rain burst measurement (8 MSB)	Depends on M ₄
Byte 20	DC measurement of IR channel A, after the Rain burst measurement (8 LSB)	Depends on M ₄
Byte 21	DC measurement of IR channel B, after the Rain burst measurement (8 MSB)	Depends on M ₄
Byte 22	DC measurement of IR channel B, after the Rain burst measurement (8 LSB)	Depends on M ₄
Byte 23	CRC (8 bit)	Output always

Table 16: SM Output Data Frame

When certain measurements are disabled, the corresponding data bytes are omitted from the Output Data Frame.

Cyclic Redundancy Check Calculation

In all Output Data Frames, a CRC byte is included as last byte. This byte provides a way to detect transmission errors between slave and master. An easy method to check if there were no transmission errors is to calculate the CRC of the whole read-out frame as defined in previous tables. When the calculated CRC results in 0x00, the transmission was error free. If the resulting CRC is not equal to zero, then an error occurred in the transmission and all the data should be ignored.

For more information regarding the CRC calculation, please refer to section 7.8.



Rain-/Light-Sensor IC for Automotive

7.2.2.8 SM+RO - Start Measurement combined with Read-Out

If after upload of the SM command, extra clocks are given (without putting *CS* high!), the data stored in the internal registers will appear on the *MISO* pin. At the end of the read-out phase the internal registers will be cleared to avoid memory effects in the next read-outs.

The newly uploaded SM command will be executed after the read-out, when the CS pin goes high.

The two figures below show the difference between the two modes of operation:

- Figure 16 shows the operation with separate SM and RO commands. After upload of a SM command, the measurement cycle will start and the internal registers will be filled. Once the *DR* pin is high, the RO command can be uploaded to start the read-out cycle. All data of the internal registers will be transferred and at the end of the read-out the registers will be cleared.
- Figure 17 shows the operation with the combined SM and RO. First one has to upload a SM command to start a measurement. The data is available for read-out when the *DR* pin goes high. Instead of uploading a RO command, a SM command can be uploaded again to combine read-out and the start of the next measurement cycle. If extra clocks are given after upload of the SM command, the data of the internal registers becomes available on the *MISO* pin. Note that the *CS* pin shall not be set high until the read-out is finished. Once *CS* pin goes high, the *DR* pin is set low and a new measurement cycle will be started. A time t_{dr} later the *DR* pin goes high to indicate that the data is available.

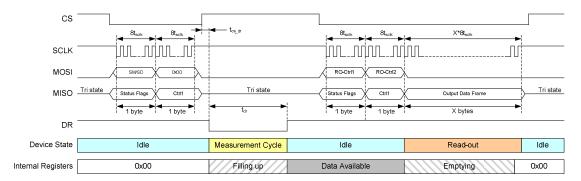


Figure 16: Separated SM - RO (X value is defined in Figure 15)

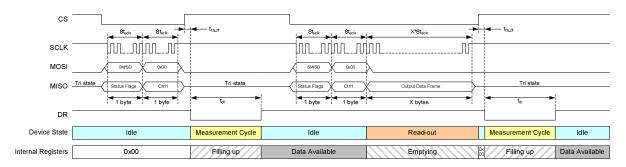


Figure 17: Combined SM - RO (X value is defined in Figure 15)



Rain-/Light-Sensor IC for Automotive

7.2.2.9 WR/RR - Write/Read Register

The slave contains several user registers that can be read and written by the master. The WR and RR commands are used for that.

The WR command writes the contents of an 8-bit register addressed by bits $A_{3..0}$ with data $D_{7..0}$. Data is sent to the device over the *MOSI* pin. Control2 Byte contains the 8 bit data that shall be written into the target register. Control3 Byte contains the address of the target register.

The WR command is defined in the table below:

Control1 Byte	Control2 Byte Control3 Byte			
1000 0111	$D_7D_6D_5D_4$ $D_3D_2D_1D_0$ $A_3A_2A_1A_0$ P_1P_000			
$D_7D_6D_5D_4\ D_3D_2D_1D_0\ A_3A_2A_1A_0\ P_1P_0$	Data contents of register to be written Address of target register Parity bits (P_1 = odd parity bit, P_0 = even parity bit)			
Data1 Byte	Data2 Byte	Data3 Byte		
Status Flag Byte	1000 0111	0000 0000		

Table 17: Write Register command

In order to detect some transmission errors while writing data towards the slave device, the micro-controller has to compute an odd and an even parity bit of the Control2 and the 4 MSB's of the Control3 byte and send these parity bits to the slave. The slave will check if the parity bits are valid. The data will only be written into the registers if the parity bits are correct. If the parity bits are not correct, bit 7 of the internal Status Flag Byte will be set high, indicating that the command was invalid. This can be seen when uploading a NOP command (when one is only interested in reading back the internal status flags) or during upload of the next command. In case the parity bits were not correct, the data of the registers will not be changed.

The parity bits calculation is based on the data $D_7..D_0$ and $A_3..A_0$. If the number of ones in the given data set $[D_7..D_0, A_3..A_0]$ is odd, the even parity bit P_0 shall be set to 1, making the total number of ones in the set $[D_7..D_0, A_3..A_0, P_0]$ even.

Similar: if the number of ones in the given data set $[D_7..D_0, A_3..A_0]$ is even, the odd parity bit P_1 shall be set to 1, making the total number of ones in the set $[D_7..D_0, A_3..A_0, P_1]$ odd.

Note that the parity bits can be generated with XOR instructions: $P_1 = XNOR(D_7..D_0, A_3..A_0)$ and $P_0 = XOR(D_7..D_0, A_3..A_0)$. The odd parity bit P_1 should always be the inverse of the even parity bit P_0 .

The RR command returns the contents of an 8-bit register addressed by bits $A_{3..0}$. Data is read back over the *MISO* pin. The Data1 Byte contains the Internal Status Flag byte. Data2 Byte contains the copy of the Control1 Byte. Data3 Byte contains the 8 bits of the target register.

The RR command is defined in the table below:



Rain-/Light-Sensor IC for Automotive

Control1 Byte	Control2 Byte Control3 Byte				
1000 1110	A ₃ A ₂ A ₁ A ₀ 0000 0000				
$A_3A_2A_1A_0$	Address of target register				
Data1 Byte	Data2 Byte	Data3 Byte			
Status Flag Byte	1000 1110	$D_7D_6D_5D_4$ $D_3D_2D_1D_0$			
D ₇ ₀	Data contents of register read				

Table 18: Read Register command

Note that the WR and RR commands are commands that require 3 bytes instead of 2 bytes.

An overview of the user registers that can be accessed with WR/RR commands and more general information concerning the user registers can be found in section 7.4

7.2.2.10 SD - Start Diagnostics

The SD command will start a measurement cycle in which internal signals will be measured and converted. With this command it is possible to test some circuits in the chip and check if they are functioning as expected.

The SD command behaves in much the same way as the SM commands: instead of uploading a SM command, a SD command can be uploaded. This starts the measurement cycle and conversion of some internal signals. The pin *DR* goes high when the cycle is completed, indicating that a read-out can be started. With the RO command it is possible to read out the data and check if all the data values are within certain ranges.

After upload of a SD command, no other commands will be accepted untill *DR* is high. This is done to avoid too many disturbances in the analog part. Once *DR* is high, the next command will be accepted. An exception however is the Chip Reset command. This will always be accepted. The SD command is not available in Standby Mode.

Similar to the SM command, the SD command has some measurement selection bits $M_6..M_0$ in the Control2 Byte. Different measurements can be selected with these bits:

- M₆: setting this bit high enables the ADC diagnostics
- M₅: setting this bit high enables the DAC-ADC diagnostics
- M₄: setting this bit high enables the Ambient Diode checks
- M₃..M₀: (reserved)

Table 19 gives an overview of some execution times t_{dr} for the basic types of measurements.

Measurement Type	Min. t _{dr} (μs)	Max. t _{dr} (μs)
ADC Diagnostics	224	249
DAC-ADC Diagnostics	91	102
Ambient Diode checks	370	410
ADC + DAC-ADC + Ambient Diode Diagnostics	680	752

Table 19: Basic Measurement Execution Times t_{dr}



Rain-/Light-Sensor IC for Automotive

If all possible measurements are selected, the Output Data Frame is defined in the table below:

Data Byte Number	Data Byte Contents after SD command	Comments
Byte 3	ADCtest0 (8 MSB)	Depends on M ₆
Byte 4	ADCtest0 (8 LSB)	Depends on M ₆
Byte 5	ADCtest1 (8 MSB)	Depends on M ₆
Byte 6	ADCtest1 (8 LSB)	Depends on M ₆
Byte 7	ADCtest2 (8 MSB)	Depends on M ₆
Byte 8	ADCtest2 (8 LSB)	Depends on M ₆
Byte 9	ADCtest3 (8 MSB)	Depends on M ₆
Byte 10	ADCtest3 (8 LSB)	Depends on M ₆
Byte 11	ADCtest4 (8 MSB)	Depends on M ₆
Byte 12	ADCtest4 (8 LSB)	Depends on M ₆
Byte 13	DAC-ADC Test (8 MSB)	Depends on M ₅
Byte 14	DAC-ADC Test (8 LSB)	Depends on M ₅
Byte 15	00000 + CDE Ambient Diodes Detection (3 bit)	Depends on M₄
Byte 16	CRC (8 bit)	Output always

Table 20: SD Output Data Frame

When certain measurements are disabled, the corresponding data bytes are omitted from the Output Data Frame.

ADCtest0/1/2/3/4

These measurements are AD conversions of some internal reference voltages:

- ADCtest0 is typically at 1/16 of the ADC range: ADCtest0 = 0x0E00 .. 0x1200.
- ADCtest1 is typically at 1/4=4/16 of the ADC range: ADCtest1 = 0x3E00 .. 0x4200.
- ADCtest2 is typically at 3/4=12/16 of the ADC range: ADCtest2 = 0xBE00 .. 0xC200.
- ADCtest3 is typically at 15/16 of the ADC range: ADCtest3 = 0xEE00 .. 0xF200.

ADCtest4 is similar to ADCtest0/1/2/3: an AD conversion of an internal reference voltage is made. However, an independent voltage reference is used as input for the ADC in case of ADCtest4. In the case of ADCtest0/1/2/3, the reference voltages are generated from the references used for the ADC. The typical output for ADCtest4 will be at half of the ADC range: ADCtest4 = 0x7888 .. 0x89D0. These values are valid for VDD=3.3V +/-2%.

DAC-ADC test

A DAC-ADC test measurement is performed in the following way: the DAC output is connected to the ADC input. The DAC input will be DACA<7:0> from register 'SetAH'. This DAC-input will be converted to an analog output voltage that will be converted again by the ADC to give a digital value. This digital value is given in the bytes DAC-ADC Test.

Ambient Diodes Detection

During the Diagnostics measurement, the status of the external photo diodes connected to the ambient light channel inputs is checked.

Three bits b'CDE are output: when the bit C is set high, an error on the photo diode channel C is present. In a similar way, bits D and E indicate if errors on ambient light channels D and E are present or not.

Rain-/Light-Sensor IC for Automotive

7.3 Internal Status Flags

Bit 7: Previous Command invalid/valid

When an uploaded command is considered invalid, bit 7 will be set high. This bit can be read out when the next command will be uploaded. If the next command is valid, bit 7 will be cleared again.

A command is considered invalid in case:

- a command is unknown (i.e. all commands that are not mentioned in Table 13)
- the parity bit in the SM or SD command is not correct
- the parity bits in a WR command are not correct
- when a command (except the CR command) was sent during a measurement cycle (i.e. after uploading a SM/SD command, when *DR* is still low)
- when a RO command was sent when *DR* is low (at any time, i.e. not only after uploading a SM/SD command)
- if a '1' is written into one of the bits of the 'Err' register
- if an ambient measurement is requested in case all bits EN_CH_C/EN_CH_D/EN_CH_E are zero

Bit 6..5: Power State, Bit 4: Sleep request, Bit 3: Standby request

The behaviour of the power state and the sleep request bits is explained in Figure 18.

First a RSLP command is uploaded to the sensor. As a result of that, the sensor will put the status flag bit 4 (sleep request flag) high. The master can read out that flag by uploading a NOP command, or when uploading other commands.

The master can confirm to go into sleep mode by uploading a CSLP command. The request flag will be reset and the sensor will switch into sleep state. The status flag bits 6 and 5 will be set accordingly.

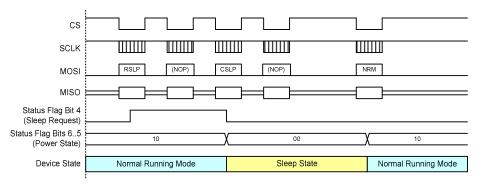


Figure 18: Power State and Sleep Request bits

To go into standby mode, the same procedure shall be applied: uploading a RSTBY command makes the request standby flag going high. Uploading a CSTBY will make the device going into standby mode, whereby the request standby flag will be cleared and the power state bits will be set accordingly.

Bit 2: Device in TestMode/Normal Mode

To make the sensor efficiently testable in production, several test modes are foreseen to get easy access to different blocks. The status flag bit 2 indicates if the device is operating in Test Mode or Normal Mode. If the device enters test mode by accident, the application will still work like normal. However, the status flag bit 2 will be set high. The master can take actions to get out of test mode by uploading a CR command.

Bit 1: Internal Oscillator is enabled/disabled

This bit is high when the internal oscillator is enabled. Once the RCO is shut down the bit will be set low.

Bit 0: Critical Error is detected/not detected

During each measurement cycle there is a monitoring of the voltage on critical nodes along the analog paths. When the voltage of one of these controlled nodes goes out of its normal operating range, the Critical Error Flag will be set high.



Rain-/Light-Sensor IC for Automotive

The Critical Error Flag will also be set high when a falling edge on the WT pin is detected while the device is in Sleep Mode.

Following nodes are monitored:

- TIA output: when the output is clipped (either high or low), the Critical Error Flag will be set high
- Difference between DAC output and shunt-feedback
- An internal reference voltage
- Output of the common mode SC-amplifiers of the Ambient Light/Temperature Channels
- Frequency on RCO output

In case the Critical Error Flag was set high, the 'Err' register indicates which node voltages got out of their normal operating range. More info about the 'Err' register can be found in Section 7.4.7.

The Critical Error Flag remains high as long as the 'Err' register is not cleared. Once the 'Err' register is cleared, the Critical Error Flag will be cleared as well.

Note: after POR, or after wake-up from Sleep/Standby, some bits in the 'Err' register might be set. As such the Critical Error Flag might be set as well.



Rain-/Light-Sensor IC for Automotive

7.4 User Registers Overview

Name	Address	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
SetAna	0x0	Tdem3	Tdem2	Tdem1	Tdem0	LEDDRV_HG	Tdc_pulse1	Tdc_pulse0	Unity_Gain
SetAH	0x1	DACA7	DACA6	DACA5	DACA4	DACA3	DACA2	DACA1	DACA0
SetAL	0x2	GAIN_ADJ_ AA_A2	GAIN_ADJ_ AA_A1	GAIN_ADJ_ AA_A0	BW_ADJ_ AA_A2	BW_ADJ_ AA_A1	BW_ADJ_ AA_A0	BW_SEL_ LP_A1	BW_SEL_ LP_A0
SetBH	0x3	DACB7	DACB6	DACB5	DACB4	DACB3	DACB2	DACB1	DACB0
SetBL	0x4	GAIN_ADJ_ AA_B2	GAIN_ADJ_ AA_B1	GAIN_ADJ_ AA_B0	BW_ADJ_ AA_B2	BW_ADJ_ AA_B1	BW_ADJ_ AA_B0	BW_SEL_ LP_B1	BW_SEL_ LP_B0
SetPF	0x5	NP3	NP2	NP1	NP0	EN_DCCOMP	RPF2	RPF1	RPF0
Err	0x6	-	Err6	Err5	Err4	Err3	Err2	Err1	-
Rst	0x7	DC_COMP_ IC13	DC_COMP_ IC12	DC_COMP_ IC11	DC_COMP_ IC10	-	-	ТО	POR
DCComp1	0x8					DC_COMP_ IC23	DC_COMP_ IC22	DC_COMP_ IC21	DC_COMP_ IC20
DCComp2	0x9	DC_COMP_ IC33	DC_COMP_ IC32	DC_COMP_ IC31	DC_COMP_ IC30	DC_COMP_ IC43	DC_COMP_ IC42	DC_COMP_ IC41	DC_COMP_ IC40
GainBuf	0xA	-	-	-	GAIN_BUF4	GAIN_BUF3	GAIN_BUF2	GAIN_BUF1	GAIN_BUF0
Calib1	0xB	TRIM_ TC_BGI4	TRIM_ TC_BGI3	TRIM_ TC_BGI2	TRIM_ TC_BGI1	TRIM_ TC_BGI0	-	-	-
Calib2	0xC	-	-	TRIM_ TEMP5	TRIM_ TEMP4	TRIM_ TEMP3	TRIM_ TEMP2	TRIM_ TEMP1	TRIM_ TEMP0
EnChan	0xD	EN_TEMP	EN_DIAG_A	EN_DIAG_B	EN_CH_A	EN_CH_B	EN_CH_C	EN_CH_D	EN_CH_E
Tamb	0xE	DC_COMP_ IC53	DC_COMP_ IC52	DC_COMP_ IC51	DC_COMP_ IC50	-	-	Tamb1	Tamb0

In the next sections, all the bits of these registers are described. The value of the register at Power-On is indicated in the line 'Init' (0 or 1 or x=unknown) and the read/write access ability is indicated in the line 'Read/Write' (R indicates Read access, W indicates Write access).

Rain-/Light-Sensor IC for Automotive

7.4.1 SetAna register

This register contains some settings of the analog chain.

	Bit	7	6	5	4	3	2	1	0
SetAna		Tdem3	Tdem2	Tdem1	Tdem0	LEDDRV_HG	Tdc_ pulse1	Tdc_ pulse0	Unity_Gain
0x0	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
	Init	0	0	0	0	0	1	0	1

Tdem<3:0>: changes the demodulator delay time in the rain channel

Tdem3	Tdem2	Tdem1	Tdem0	Delay time (in μs, +/-5%)
0	0	0	0	0
0	0	0	1	0.4
0	0	1	0	0.8
0	0	1	1	1.2
0	1	0	0	1.6
0	1	0	1	2
0	1	1	0	2.4
0	1	1	1	2.8
1	0	0	0	3.2
1	0	0	1	3.6
1	0	1	0	4
1	0	1	1	4.4
1	1	0	0	4.8
1	1	0	1	5.2
1	1	1	0	5.6
1	1	1	1	6

- LEDDRV HG: 1 = selects high gain mode of LED driver, 0 = selects low gain mode
- Tdc_pulse<1:0>: defines the time that the DC component in the rain pulse signal is enabled before the actual rain pulses start

Tdc_ pulse1	Tdc_ pulse0	Delay time (in μs, +/-5%)
0	0	50
0	1	100
1	0	200
1	1	400

 Unity_Gain: only during rain measurements: 1=ADC buffer is bypassed, 0=ADC gain stage is used (gain is set with bits GAIN_BUF<4:0> in register 'GainBuf')

Rain-/Light-Sensor IC for Automotive

7.4.2 SetAH register

This register defines the DAC level for IR channel A.

	Bit	7	6	5	4	3	2	1	0
SetAH		DACA7	DACA6	DACA5	DACA4	DACA3	DACA2	DACA1	DACA0
0x1	Read/Write	R/W							
	Init	0	0	0	0	0	0	0	0

DACA<7:0>: the 8 bits of the DAC level for IR channel A

7.4.3 SetAL register

This register defines the gain and cut-off frequency adjustments for IR channel A.

	Bit	7	6	5	4	3	2	1	0	
		GAIN_	GAIN_	GAIN_	BW_	BW_	BW_	BW_	BW_	ĺ
SetAL		ADJ_	ADJ_	ADJ_	ADJ_	ADJ_	ADJ_	SEL_	SEL_	ĺ
		AA_A2	AA_A1	AA_A0	AA_A2	AA_A1	AA_A0	LP_A1	LP_A0	ĺ
0x2	Read/Write	R/W								
	Init	0	0	0	0	1	1	0	1	

GAIN_ADJ_AA_A<2:0>: gain adjustment of anti-aliasing filter of channel A

GAIN_ADJ_ AA_A2	GAIN_ADJ_ AA_A1	GAIN_ADJ_ AA_A0	Gain	Gain (dB)
0	0	0	2.00	6.02
0	0	1	4.29	12.64
0	1	0	6.57	16.35
0	1	1	8.86	18.95
1	0	0	11.14	20.94
1	0	1	13.43	22.56
1	1	0	15.71	23.93
1	1	1	18.00	25.11

BW_ADJ_AA_A<2:0>: cut-off frequency adjustment of anti-aliasing filter of channel A

BW_ADJ_ AA_A2	BW_ADJ_ AA_A1	BW_ADJ_ AA_A0	3dB Cut-off Frequency (kHz)
0	0	0	18
0	0	1	20
0	1	0	22.5
0	1	1	25
1	0	0	30
1	0	1	35
1	1	0	43
1	1	1	55

BW_SEL_LP_A<1:0>: cut-off frequency selection of low-pass filter of channel A

Data Sheet

Nov/11

Rain-/Light-Sensor IC for Automotive

BW_SEL_ LP_A1	BW_SEL_ LP_A0	Cut-off Frequency (%f ₀)	Cut-off Frequency (kHz @ f ₀ =70kHz)
0	0	≅23.5	≅16.5
0	1	≅12	≅7.8
1	0	≅5.9	≅4.2
1	1	≅3	≅2.1

7.4.4 SetBH register

This register defines the DAC level for IR channel B.

	Bit	7	6	5	4	3	2	1	0
SetBH		DACB7	DACB6	DACB5	DACB4	DACB3	DACB2	DACB1	DACB0
0x3	Read/Write	R/W							
	Init	0	0	0	0	0	0	0	0

DACB<7:0>: the 8 bits of the DAC level for IR channel B

7.4.5 SetBL register

This register defines the gain and cut-off frequency adjustments for IR channel B.

	Bit	7	6	5	4	3	2	1	0
		GAIN_	GAIN_	GAIN_	BW_	BW_	BW_	BW_	BW_
SetBL		ADJ_	ADJ_	ADJ_	ADJ_	ADJ_	ADJ_	SEL_	SEL_
		AA_B2	AA_B1	AA_B0	AA_B2	AA_B1	AA_B0	LP_B1	LP_B0
0x4	Read/Write	R/W							
	Init	0	0	0	0	1	1	0	1

• GAIN_ADJ_AA_B<2:0>: gain adjustment of anti-aliasing filter of channel B

GAIN_ADJ_ AA_B2	GAIN_ADJ_ AA_B1	GAIN_ADJ_ AA_B0	Gain	Gain (dB)
0	0	0	2.00	6.02
0	0	1	4.29	12.64
0	1	0	6.57	16.35
0	1	1	8.86	18.95
1	0	0	11.14	20.94
1	0	1	13.43	22.56
1	1	0	15.71	23.93
1	1	1	18.00	25.11

BW_ADJ_AA_B<2:0>: cut-off frequency adjustment of anti-aliasing filter of channel B

BW_ADJ_ AA_B2	BW_ADJ_ AA_B1	BW_ADJ_ AA_B0	3dB Cut-off Frequency (kHz)
0	0	0	18
0	0	1	20
0	1	0	22.5
0	1	1	25



Rain-/Light-Sensor IC for Automotive

1	0	0	30
1	0	1	35
1	1	0	43
1	1	1	55

BW_SEL_LP_B<1:0>: cut-off frequency selection of low-pass filter of channel B

BW_SEL_ LP_B1	BW_SEL_ LP_B0	Cut-off Freuency (%f ₀)	Cut-off Frequency (kHz @ f ₀ =70kHz)
0	0	≅23.5	≅16.5
0	1	≅12	≅7.8
1	0	≅5.9	≅4.2
1	1	≅3	≅2.1

7.4.6 SetPF register

This register defines the frequency settings and the number of pulses for the rain measurements.

	Bit	7	6	5	4	3	2	1	0	_
SetPF		NP3	NP2	NP1	NP0	EN_DC COMP	RPF2	RPF1	RPF0	
0x5	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	•
	Init	0	1	0	0	0	1	0	0	

• NP<3:0>: number of pulses for the rain measurements, as defined in the table below:

Bit 3 - NP3	Bit 2 - NP2	Bit 1 - NP1	Bit 0 - NP0	Number of Pulses
0	0	0	0	2
0	0	0	1	4
0	0	1	0	6
0	0	1	1	8
0	1	0	0	10
0	1	0	1	12
0	1	1	0	14
0	1	1	1	16
1	0	0	0	18
1	0	0	1	20
1	0	1	0	22
1	0	1	1	24
1	1	0	0	26
1	1	0	1	28
1	1	1	0	30
1	1	1	1	32

- EN_DCCOMP: 1 = enables the DC light compensation, 0 = disables the DC light compensation
- RPF<2:0>: frequency selection of pulses for the rain measurements, as defined below:



Rain-/Light-Sensor IC for Automotive

Bit 2 - RPF2	Bit 1 - RPF1	Bit 0 - RPF0	Frequency of Pulses (in kHz, +/-5%)	
0	0	0	48.1	
0	0	1	52.1	
0	1	0	56.8	
0	1	1	62.5	
1	0	0	69.4	
1	0	1	78.1	
1	1	0	89.3	
1	1	1	104.2	

7.4.7 Err register

As described in Section 7.3 (under section 'Bit 0: Critical Error is detected/not detected'), the voltages on critical nodes are monitored continuously. When a voltage on such a critical node goes outside its operating range, the Critical Error Flag and the appropriate error bit in the 'Err' register will be set high. As such, the source of the error can be found in the 'Err' register.

The error bit remains high as long as the error condition is present, or as long as the error bit is not cleared (in case the error condition is not present anymore).

	Bit	7	6	5	4	3	2	1	0
Err		-	Err6	Err5	Err4	Err3	Err2	Err1	-
0x6	Read/Write	R	R/W*	R/W*	R/W*	R/W*	R/W*	R/W*	R
	Init	0	0	0	x**	x**	x**	0	0

The following bits are defined (0= no error detected; 1=error is detected):

- Err<7>: not implemented, read as '0'
- Err6: critical error detected on TIA output
- Err5: critical error detected on the difference between DAC output and shunt-feedback
- Err4: critical error detected on internal voltage reference: when the internal voltage reference is below 1V.
- Err3: critical error detected on one of the common mode SC-filters of the ambient light/temperature channels
- Err2: critical error detected on RCO: either a stuck-at-high or a stuck-at-low condition occurred at the output of the RCO. Note that in SLP, the error flag on the RCO will be set high.
- Err1: set to '1' when a falling edge on the WT pin is detected while the device is in Sleep Mode
- Err<0>: not implemented, read as '0'

^{*:} only writing '0' is allowed. If a '1' is written, the bit value in the register will not be changed, but Bit 7 of the Internal Status Flags will be set high (Previous Command Invalid).

^{**: &#}x27;x' indicates that the value after POR is unknown. If the voltages of the nodes are out of range right after POR, it will be immediately reflected in the 'Err' register and the Critical Error Flag will be set. The same is valid after wake-up from Sleep/Standby.

Rain-/Light-Sensor IC for Automotive

7.4.8 Rst register

This register allows differentiation of either a POR or a reset due to a watchdog time-out + settings for the DC light compensation circuitry.

	Bit	7	6	5	4	3	2	1	0
Rst		DC_ COMP_ IC13	DC_ COMP_ IC12	DC_ COMP_ IC11	DC_ COMP_ IC10	ı	-	ТО	POR
0x7	Read/Write	R/W	R/W	R/W	R/W	R	R	R	R/W
	Init	0	0	0	0	0	0	0	1

- DC_COMP_IC1<3:0>: setting of the amplitude of the 1st PWL slope
- Rst<3:2>: not implemented, read as '0'
- TO: 1=a Watchdog time-out and a master reset occurred. 0=no Watchdog time-out occurred, or after Power-On, or after a falling edge at the WT pin
- POR: 1=a POR occurred, 0=a POR has not occurred. To detect subsequent Power-On-Resets, the POR-bit shall be cleared right after Power-On.

7.4.9 DCComp register

This register contains settings for the DC light compensation circuitry. This settings have to be calculated for the individual application (rain-channel photodiode used).

	Bit	7	6	5	4	3	2	1	0
DCComp1						DC_ COMP_ IC23	DC_ COMP_ IC22	DC_ COMP_ IC21	DC_ COMP_ IC20
0x8	Read/ Write	R	R	R	R	R/W	R/W	R/W	R/W
	Init	X	X	Χ	Χ	0	0	0	0

DC COMP IC2<3:0>: setting of the amplitude of the 2nd PWL slope

	Bit	7	6	5	4	3	2	1	0
DCComp2		DC_ COMP_ IC33	DC_ COMP_ IC32	DC_ COMP_ IC31	DC_ COMP_ IC30	DC_ COMP_ IC43	DC_ COMP_ IC42	DC_ COMP_ IC41	DC_ COMP_ IC40
0x9	Read/ Write	R/W							
	Init	0	0	0	0	0	0	0	0

- DC_COMP_IC3<3:0>: setting of the amplitude of the 3rd PWL slope
- DC_COMP_IC4<3:0>: setting of the amplitude of the 4th PWL slope

Rain-/Light-Sensor IC for Automotive

7.4.10 GainBuf register

This register contains the gain settings of the ADC input buffer. The use of this buffer is depending on bit 'Unity_Gain' in the register 'SetAna'.

	Bit	7	6	5	4	3	2	1	0
GainBuf		ı	-	-	GAIN_ BUF4	GAIN_ BUF3	GAIN_ BUF2	GAIN_ BUF1	GAIN_ BUF0
0xA	Read/Write Init	R o	R o	R 0	R/W	R/W 1	R/W	R/W 1	R/W

- GainBuf<7:5>: not implemented, read as '0'
- GAIN_BUF<4:0>: defines the gain setting of the ADC input buffer

GAIN_ BUF4	GAIN_ BUF3	GAIN_ BUF2	GAIN_ BUF1	GAIN_ BUF0	Gain
0	0	0	0	1	2
0	0	0	1	0	1
0	0	0	1	1	0.67
0	0	1	0	0	0.5
0	0	1	0	1	0.4
0	0	1	1	0	0.33
0	0	1	1	1	0.29
0	1	0	0	0	0.25
0	1	0	0	1	0.22
0	1	0	1	0	0.2
1	0	0	0	1	10
1	0	0	1	0	5
1	0	0	1	1	3.33
1	0	1	0	0	2.5
1	0	1	0	1	2
1	0	1	1	0	1.67
1	0	1	1	1	1.43
1	1	0	0	0	1.25
1	1	0	0	1	1.11
1	1	0	1	0	1

Rain-/Light-Sensor IC for Automotive

7.4.11 Calib1/Calib2 register

These registers contain the gain settings of the bandgap TC correction and the temperature sensor.

	Bit	7	6	5	4	3	2	1	0
Calib1		TRIM_ TC_BGI4	TRIM_ TC_BGI3	TRIM_ TC_BGI2	TRIM_ TC_BGI1	TRIM_ TC_BGI0	1	1	-
0xB	Read/Write	R	R	R	R	R	R	R	R
	Init	Х	X	X	X	X	0	0	0

- TRIM TC BGI<4:0>: defines the TC correction of the bandgap current
- Calib1<2:0>: not implemented, read as '0'

The Calib1 register is used to indicate the slope of the temperature sensor curve in LSB/Kelvin. The slope is calculated out of a 2-point measurement of the temperature curve and is permanently programmed in the OTP by means of a 5-Bit word and accessible via the Calib1 register, see Table 21.

Calib1 - T	RIM_TC_BGI	
Dec	Bin	Slope (LSB/Kelvin)
0	0	-51
1	1	-52
2	10	-53
3	11	-54
4	100	-55
5	101	-56
6	110	-57
7	111	-58
8	1000	-59
9	1001	-60
10	1010	-61
11	1011	-62
12	1100	-63
13	1101	-64
14	1110	-65
15	1111	-66
16	10000	-67
17	10001	-68
18	10010	-69
19	10011	-70
20	10100	-71
21	10101	-72
22	10110	-73
23	10111	-74
24	11000	-75
25	11001	-76
26	11010	-77
27	11011	-78
28	11100	-79
29	11101	-80
30	11110	-81
31	11111	-82

Table 21: 5-Bit temperature sensor slope information as it is stored in the calib1 register.



Rain-/Light-Sensor IC for Automotive

	Bit	7	6	5	4	3	2	1	0
Calib2		-	-	TRIM_ TEMP5	TRIM_ TEMP4	TRIM_ TEMP3	TRIM_ TEMP2	TRIM_ TEMP1	TRIM_ TEMP0
0xC	Read/Write	R	R	R	R	R	R	R	R
	Init	0	0	Х	X	X	X	X	X

- Calib2<7:6>: not implemented, read as '0' TRIM_TEMP<5:0>: defines the calibration settings of the temperature sensor

The offset of the temperature curve is measured at one temperature (preferably 30deg. C) and permanently stored in the zenerzap OTP with 6 bit word length. This information is accessible via the Calib2 register, see Table 22.

Calib2 - T	RIM TEM	D			Slope: -6	7 LSB/K		
Odilb2 - 1	1 111VI_1 E1VI	•		25degC			30degC	
Dec	Bin	Offset (degC)	LSL	expected	USL	LSL	expected	USL
1	1	-31	10003.07	10036.51	10069.95	9668.67	9702.11	9735.55
2	10	-30	10069.95	10103.39	10136.83	9735.55	9768.99	9802.43
3	11	-29	10136.83	10170.27	10203.71	9802.43	9835.87	9869.31
4	100	-28	10203.71	10237.15	10270.59	9869.31	9902.75	9936.19
5	101	-27	10270.59	10304.03	10337.47	9936.19	9969.63	10003.07
6	110	-26	10337.47	10370.91	10404.35	10003.07	10036.51	10069.95
7	111	-25	10404.35	10437.79	10471.23	10069.95	10103.39	10136.83
8	1000	-24	10471.23	10504.67	10538.11	10136.83	10170.27	10203.71
9	1001	-23	10538.11	10571.55	10604.99	10203.71	10237.15	10270.59
10	1010	-22	10604.99	10638.43	10671.87	10270.59	10304.03	10337.47
11	1011	-21	10671.87	10705.31	10738.75	10337.47	10370.91	10404.35
12	1100	-20	10738.75	10772.19	10805.63	10404.35	10437.79	10471.23
13	1101	-19	10805.63	10839.07	10872.51	10471.23	10504.67	10538.11
14	1110	-18	10872.51	10905.95	10939.39	10538.11	10571.55	10604.99
15	1111	-17	10939.39	10972.83	11006.27	10604.99	10638.43	10671.87
16	10000	-16	11006.27	11039.71	11073.15	10671.87	10705.31	10738.75
17	10001	-15	11073.15	11106.59	11140.03	10738.75	10772.19	10805.63
18	10010	-14	11140.03	11173.47	11206.91	10805.63	10839.07	10872.51
19	10011	-13	11206.91	11240.35	11273.79	10872.51	10905.95	10939.39
20	10100	-12	11273.79	11307.23	11340.67	10939.39	10972.83	11006.27
21	10101	-11	11340.67	11374.11	11407.55	11006.27	11039.71	11073.15
22	10110	-10	11407.55	11440.99	11474.43	11073.15	11106.59	11140.03
23	10111	-9	11474.43	11507.87	11541.31	11140.03	11173.47	11206.91
24	11000	-8	11541.31	11574.75	11608.19	11206.91	11240.35	11273.79
25	11001	-7	11608.19	11641.63	11675.07	11273.79	11307.23	11340.67
26	11010	-6	11675.07	11708.51	11741.95	11340.67	11374.11	11407.55
27	11011	-5	11741.95	11775.39	11808.83	11407.55	11440.99	11474.43
28	11100	-4	11808.83	11842.27	11875.71	11474.43	11507.87	11541.31
29	11101	-3	11875.71	11909.15	11942.59	11541.31	11574.75	11608.19
30	11110	-2	11942.59	11976.03	12009.47	11608.19	11641.63	11675.07
31	11111	-1	12009.47	12042.91	12076.35	11675.07	11708.51	11741.95
32	100000	0	12076.35	12109.79	12143.23	11741.95	11775.39	11808.83
33	100001	1	12143.23	12176.67	12210.11	11808.83	11842.27	11875.71



Rain-/Light-Sensor IC for Automotive

		•	-	•	•	•	1	
34	100010	2	12210.11	12243.55	12276.99	11875.71	11909.15	11942.59
35	100011	3	12276.99	12310.43	12343.87	11942.59	11976.03	12009.47
36	100100	4	12343.87	12377.31	12410.75	12009.47	12042.91	12076.35
37	100101	5	12410.75	12444.19	12477.63	12076.35	12109.79	12143.23
38	100110	6	12477.63	12511.07	12544.51	12143.23	12176.67	12210.11
39	100111	7	12544.51	12577.95	12611.39	12210.11	12243.55	12276.99
40	101000	8	12611.39	12644.83	12678.27	12276.99	12310.43	12343.87
41	101001	9	12678.27	12711.71	12745.15	12343.87	12377.31	12410.75
42	101010	10	12745.15	12778.59	12812.03	12410.75	12444.19	12477.63
43	101011	11	12812.03	12845.47	12878.91	12477.63	12511.07	12544.51
44	101100	12	12878.91	12912.35	12945.79	12544.51	12577.95	12611.39
45	101101	13	12945.79	12979.23	13012.67	12611.39	12644.83	12678.27
46	101110	14	13012.67	13046.11	13079.55	12678.27	12711.71	12745.15
47	101111	15	13079.55	13112.99	13146.43	12745.15	12778.59	12812.03
48	110000	16	13146.43	13179.87	13213.31	12812.03	12845.47	12878.91
49	110001	17	13213.31	13246.75	13280.19	12878.91	12912.35	12945.79
50	110010	18	13280.19	13313.63	13347.07	12945.79	12979.23	13012.67
51	110011	19	13347.07	13380.51	13413.95	13012.67	13046.11	13079.55
52	110100	20	13413.95	13447.39	13480.83	13079.55	13112.99	13146.43
53	110101	21	13480.83	13514.27	13547.71	13146.43	13179.87	13213.31
54	110110	22	13547.71	13581.15	13614.59	13213.31	13246.75	13280.19
55	110111	23	13614.59	13648.03	13681.47	13280.19	13313.63	13347.07
56	111000	24	13681.47	13714.91	13748.35	13347.07	13380.51	13413.95
57	111001	25	13748.35	13781.79	13815.23	13413.95	13447.39	13480.83
58	111010	26	13815.23	13848.67	13882.11	13480.83	13514.27	13547.71
59	111011	27	13882.11	13915.55	13948.99	13547.71	13581.15	13614.59
60	111100	28	13948.99	13982.43	14015.87	13614.59	13648.03	13681.47
61	111101	29	14015.87	14049.31	14082.75	13681.47	13714.91	13748.35
62	111110	30	14082.75	14116.19	14149.63	13748.35	13781.79	13815.23
63	111111	31	14149.63	14183.07	14216.51	13815.23	13848.67	13882.11



Rain-/Light-Sensor IC for Automotive

Coliba	FDIM TEM	D.			Slope: -67 l	LSB/K		
Calib2 - I	TRIM_TEM	r		85degC			105degC	
Dec	Bin	Offset (degC)	LSL	expected	USL	LSL	expected	USL
1	1	-31	5990.27	6023.71	6057.15	4652.67	4686.11	4719.55
2	10	-30	6057.15	6090.59	6124.03	4719.55	4752.99	4786.43
3	11	-29	6124.03	6157.47	6190.91	4786.43	4819.87	4853.31
4	100	-28	6190.91	6224.35	6257.79	4853.31	4886.75	4920.19
5	101	-27	6257.79	6291.23	6324.67	4920.19	4953.63	4987.07
6	110	-26	6324.67	6358.11	6391.55	4987.07	5020.51	5053.95
7	111	-25	6391.55	6424.99	6458.43	5053.95	5087.39	5120.83
8	1000	-24	6458.43	6491.87	6525.31	5120.83	5154.27	5187.71
9	1001	-23	6525.31	6558.75	6592.19	5187.71	5221.15	5254.59
10	1010	-22	6592.19	6625.63	6659.07	5254.59	5288.03	5321.47
11	1011	-21	6659.07	6692.51	6725.95	5321.47	5354.91	5388.35
12	1100	-20	6725.95	6759.39	6792.83	5388.35	5421.79	5455.23
13	1101	-19	6792.83	6826.27	6859.71	5455.23	5488.67	5522.11
14	1110	-18	6859.71	6893.15	6926.59	5522.11	5555.55	5588.99
15	1111	-17	6926.59	6960.03	6993.47	5588.99	5622.43	5655.87
16	10000	-16	6993.47	7026.91	7060.35	5655.87	5689.31	5722.75
17	10001	-15	7060.35	7093.79	7127.23	5722.75	5756.19	5789.63
18	10010	-14	7127.23	7160.67	7194.11	5789.63	5823.07	5856.51
19	10011	-13	7194.11	7227.55	7260.99	5856.51	5889.95	5923.39
20	10100	-12	7260.99	7294.43	7327.87	5923.39	5956.83	5990.27
21	10101	-11	7327.87	7361.31	7394.75	5990.27	6023.71	6057.15
22	10110	-10	7394.75	7428.19	7461.63	6057.15	6090.59	6124.03
23	10111	-9	7461.63	7495.07	7528.51	6124.03	6157.47	6190.91
24	11000	-8	7528.51	7561.95	7595.39	6190.91	6224.35	6257.79
25	11001	-7	7595.39	7628.83	7662.27	6257.79	6291.23	6324.67
26	11010	-6	7662.27	7695.71	7729.15	6324.67	6358.11	6391.55
27	11011	-5	7729.15	7762.59	7796.03	6391.55	6424.99	6458.43
28	11100	-4	7796.03	7829.47	7862.91	6458.43	6491.87	6525.31
29	11101	-3	7862.91	7896.35	7929.79	6525.31	6558.75	6592.19
30	11110	-2	7929.79	7963.23	7996.67	6592.19	6625.63	6659.07
31	11111	-1	7996.67	8030.11	8063.55	6659.07	6692.51	6725.95
32	100000	0	8063.55	8096.99	8130.43		6759.39	6792.83
33	100001	1	8130.43	8163.87	8197.31		6826.27	
34	100010	2	8197.31	8230.75	8264.19	6859.71	6893.15	6926.59
35	100011	3	8264.19	8297.63	8331.07	6926.59	6960.03	6993.47
36	100100	4	8331.07	8364.51	8397.95	6993.47	7026.91	7060.35
37	100101	5	8397.95	8431.39	8464.83	7060.35	7093.79	7127.23
38	100110	6	8464.83	8498.27	8531.71	7127.23	7160.67	7194.11
39	100111	7	8531.71	8565.15	8598.59	7194.11	7227.55	7260.99
40	101000	8	8598.59	8632.03	8665.47	7260.99	7294.43	7327.87
41	101001	9	8665.47	8698.91	8732.35	7327.87	7361.31	7394.75
42	101010	10	8732.35	8765.79	8799.23	7394.75	7428.19	7461.63
43	101011	11	8799.23	8832.67	8866.11	7461.63	7495.07	7528.51
44	101100	12	8866.11	8899.55	8932.99	7528.51	7561.95	7595.39



Rain-/Light-Sensor IC for Automotive

				_	_			_
45	101101	13	8932.99	8966.43	8999.87	7595.39	7628.83	7662.27
46	101110	14	8999.87	9033.31	9066.75	7662.27	7695.71	7729.15
47	101111	15	9066.75	9100.19	9133.63	7729.15	7762.59	7796.03
48	110000	16	9133.63	9167.07	9200.51	7796.03	7829.47	7862.91
49	110001	17	9200.51	9233.95	9267.39	7862.91	7896.35	7929.79
50	110010	18	9267.39	9300.83	9334.27	7929.79	7963.23	7996.67
51	110011	19	9334.27	9367.71	9401.15	7996.67	8030.11	8063.55
52	110100	20	9401.15	9434.59	9468.03	8063.55	8096.99	8130.43
53	110101	21	9468.03	9501.47	9534.91	8130.43	8163.87	8197.31
54	110110	22	9534.91	9568.35	9601.79	8197.31	8230.75	8264.19
55	110111	23	9601.79	9635.23	9668.67	8264.19	8297.63	8331.07
56	111000	24	9668.67	9702.11	9735.55	8331.07	8364.51	8397.95
57	111001	25	9735.55	9768.99	9802.43	8397.95	8431.39	8464.83
58	111010	26	9802.43	9835.87	9869.31	8464.83	8498.27	8531.71
59	111011	27	9869.31	9902.75	9936.19	8531.71	8565.15	8598.59
60	111100	28	9936.19	9969.63	10003.07	8598.59	8632.03	8665.47
61	111101	29	10003.07	10036.51	10069.95	8665.47	8698.91	8732.35
62	111110	30	10069.95	10103.39	10136.83	8732.35	8765.79	8799.23
63	111111	31	10136.83	10170.27	10203.71	8799.23	8832.67	8866.11

Table 22: 6-Bit Temperature curve offset information for a typical slope of -67 LSB/K.

7.4.12 EnChan register

This register contains bit to enable/disable rain and ambient light channels.

	Bit	7	6	5	4	3	2	1	0
EnChan		EN_ TEMP	EN_ DIAG_A	EN_ DIAG_B	EN_ CH_A	EN_ CH_B	EN_ CH_C	EN_ CH_D	EN_ CH_E
0xD	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
	Init	1	1	1	1	1	1	1	1

- EN_TEMP: 1 = temperature channel is in use, 0 = temperature channel is not in use
- EN DIAG A: 1 = enables diagnostics on rain channel A, 0 = disables the diagnostics
- EN_DIAG_B: 1 = enables diagnostics on rain channel B, 0 = disables the diagnostics
- EN_CH_A: 1 = rain channel A is enabled (TIA + Demodulator + Anti-Aliasing Filter + SC-LPF), 0 = rain channel A is completely switched off to reduce current consumption
- EN_CH_B: 1 = rain channel B is enabled (TIA + Demodulator + Anti-Aliasing Filter + SC-LPF), 0 = rain channel B is completely switched off to reduce current consumption
- EN CH C: 1 = ambient light channel C is in use, 0 = ambient light channel C is not in use
- EN CH D: 1 = ambient light channel D is in use, 0 = ambient light channel D is not in use
- EN CH E: 1 = ambient light channel E is in use, 0 = ambient light channel E is not in use

The bits EN_CH_A/EN_CH_B can be used to switch off channels that are not needed, and thus reducing the current consumption.

When going into Sleep or Standby the setting of these bits is ignored, all channels will be switched off independently of EN_CH_A/EN_CH_B.

The bits EN_TEMP/EN_CH_C/EN_CH_D/EN_CH_E are used to indicate which channels are in use and which channels are not in use.



Rain-/Light-Sensor IC for Automotive

In case all EN_CH_C/D/E bits are set to zero, but an ambient measurement is requested, then the Command Invalid status flag will be set high. The measurement itself will not be executed.

7.4.13 Tamb register

This register contains settings for the DC light compensation circuitry + controls the repetition rate of the auto-zero timer.

	Bit	7	6	5	4	3	2	1	0
Tamb		DC_ COMP_ IC53	DC_ COMP_ IC52	DC_ COMP_ IC51	DC_ COMP_ IC50	ı	ı	Tamb1	Tamb0
0xE	Read/Write Init	R/W 0	R/W 0	R/W 0	R/W 0	R 0	R 0	R/W 1	R/W 0

- DC COMP IC5<3:0>: setting of the amplitude of the 5th PWL slope
- Tamb<3:2>: not implemented, read as '0'
- Tamb<1:0>: controls the repetition rate of the auto-zero timer

Tamb1	Tamb0	Repetition Rate (ms +/-5%)
0	0	1.25
0	1	2.5
1	0	5
1	1	10

Rain-/Light-Sensor IC for Automotive

7.5 Window Watchdog Timer

The internal watchdog timer is a watchdog based on two different windows: an open and a closed window. During the open window the master can restart the watchdog timer. During the closed window, no restarts are accepted.

The restart (re-initialisation) of the watchdog timer happens via the WT (Watchdog Trigger) pin: when a falling edge is detected on the WT pin, the watchdog will be restarted. The low time on the WT pin should be at least a time t_{wt} .

After a POR or a reset issued by the watchdog and after a wake-up from Sleep Mode (either by uploading the NRM command, or by using the $WAKE_UP$ pin), the window watchdog will open an active window of a time t_{wdt_init} , during which a watchdog restart must be issued by the μ C. If no watchdog restart is received by the end of the open window, the μ C will be reset.

After this initial period, the window watchdog is programmed to wait a time t_{wdt_closed} during which no watchdog restarts are allowed. If a watchdog restart is sent during the closed window time, the watchdog will reset the master via the *MR* (Master Reset) pin.

After a closed window, an open window of a time t_{wdt_open} will follow during which a watchdog restart is expected. If no watchdog restart is received till the end of the open window, the μ C will be reset via the MR pin.

Changing mode between Normal Running Mode and Standby Mode will not influence the watchdog timing or state. Also a CR command will not change the used window times. The watchdog counter will not be influenced when changing mode between NRM and STBY or when uploading a CR command.

The Watch Dog Timer is disabled in Sleep Mode. A falling edge on the *WT* pin in the Sleep Mode will set an error flag in the register 'Err'. Coming back from Sleep Mode to Normal Running Mode always restarts the watchdog with the initial timing window.

This figure shows what timing windows are used in the different operating modes:

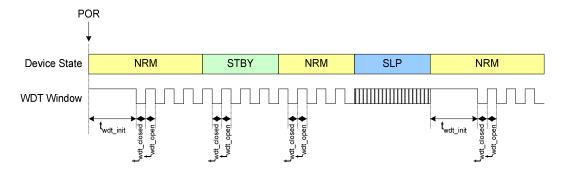


Figure 19: Window times during different operating modes

The two diagrams below show the functionality of the watchdog timer:



Rain-/Light-Sensor IC for Automotive

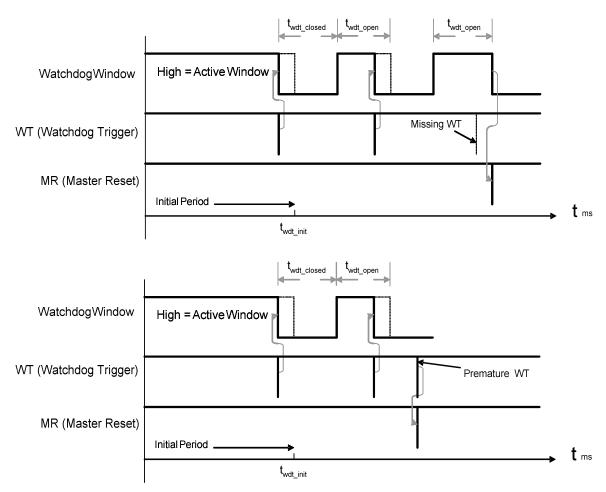


Figure 20: Functionality of the window watchdog timer

A reset of the μ C due to time-out of the watchdog is achieved by setting the MR pin low during a time t_{MR} (default state of the MR pin is high).

When the device is operating in Sleep or Standby Mode, the $WAKE_UP$ pin will be monitored. When a falling edge is detected on that pin, the device will switch to Normal Running Mode and, when waking up from Sleep Mode, the Watchdog Timer will be started (with an initial window time of t_{wdt_init}).

Note that no pull-up or pull-down resistor is foreseen on the $WAKE_UP$ pin. To avoid that parasitic spikes can wake up the device, the $WAKE_UP$ input is debounced (typical debounce time is in the range of $2\mu s$). The low time on the $WAKE_UP$ pin should be at least a time t_{wu} .



Rain-/Light-Sensor IC for Automotive

7.6 Reset Behaviour

Power-On Reset

After a Power-On Reset, the device is operating in Normal Running Mode. All internal data registers are set to their initial state:

- the device state is Normal Running Mode
- the Watchdog counter is initialized to generate the initial window time
- all registers containing (diagnostic) measurement data are initialized to 0x00
- bits 7, 4, 3 of the Internal Status Flags are cleared
- the user settings registers are set to their initial values (see Section 7.4)
- the 'Err' register will initialize to 0x00. However, as some voltages are continuously measured, it will
 reflect immediately if an error is detected or not.

The *MR* pin will be initialized to '1'. The *DR* pin will be initialized to '0', but after the time t_{startup} it will switch to '1' to indicate that the device is ready to accept the first command (see also Section 7.9).

The output of the *MISO* pin is depending on the *CS* state: if *CS* is high, the *MISO* pin is in tri-state. If *CS* is low, the output of the *MISO* pin is undefined.

CR Command

At every upload of the CR command, the device returns to the state like it is after a Power-On-Reset, except for the Watchdog counter and the state of the *MR* line. The Watchdog counter and the state of the *MR* line will not be influenced by uploading a CR command. Also, the CR command will not change the contents of the 'Rst' register.

After a CR command the DR pin will be kept low during a time t_{startup}.

Read-out

At the end of each read-out, all registers containing (diagnostic) measurement data are cleared to 0x00.

Watchdog time-out

When a reset occurs due to a watchdog time-out, the MR pin will go low for a time t_{MR} . The Watchdog counter will be initialized with the window time t_{wdt_init} . All other states, lines and registers of the ASIC will not be affected.

Changing operation mode

When changing operation mode (RSLP, CSLP, RSTBY, CSTBY, NRM) the right status flags are set. Changing operation mode will not affect the user settings registers and the (diagnostic) measurement data registers.

The DR pin will be set to '0' and after the time t_{wakeup_slp} resp. t_{wakeup_stby} it will be set to '1', when waking up from Sleep resp. Standby Mode.

Rain-/Light-Sensor IC for Automotive

7.7 Wake-up from Sleep or Standby

The figure below shows what happens when switching operation mode, and the behaviour of the *DR* pin and the watchdog timer.

The WAKE_UP pin is only monitored during Sleep and Standby. When a falling edge is detected during Sleep or Standby, the following will happen:

- the DR pin goes low for a time $t_{\text{wakeup_stby}}$ or $t_{\text{wakeup_slp}}$
- the watchdog timer is initialised and starts counting, when waking up from Sleep
- the device changes to Normal Running Mode, enabling the appropriate blocks

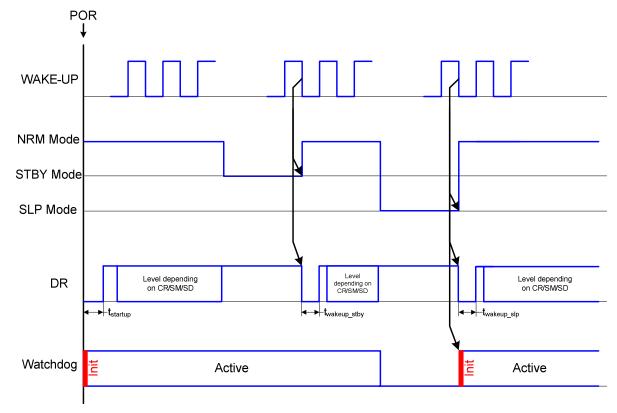


Figure 21: Behaviour of DR and Watchdog when switching mode



Rain-/Light-Sensor IC for Automotive

7.8 CRC Calculation

The 8-bit CRC calculation will be based on the polynomial $x^8 + x^2 + x^1 + x^0$. This polynomial is widely used in the industry, it is e.g. used for generating:

- the Header Error Correction field in ATM (Asynchronous Transfer Mode) cells
- the Packet Error Code in SMBus data packets

Some probabilities of detecting errors when using this polynomial:

- 100% detection of one bit errors
- 100% detection of double bit errors (adjacent bits)
- 100% detection of two single-bit errors for frames less than 128 bits in length
- 100% detection of any odd number of bits in error
- 100% detection of burst errors up to 8 bits
- 99.61% detection of any random error

A possible hardware implementation using a Linear Feedback Shift Register (LFSR) is shown in the figure below:

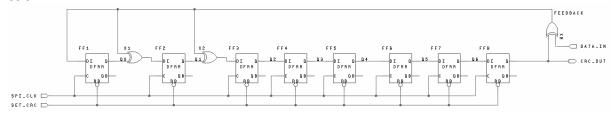


Figure 22: 8-bit CRC implementation using a LFSR

The generation of the CRC requires the following steps:

- Reset all flip-flops
- 0x00 is the initial value, shifting in all zeroes does not affect the CRC
- Shift in the read-out data bytes. First byte is Data Byte 1 (= Internal Status Flags), last byte is Data Byte (X+1) (with X defined in Figure 15).
- When the last byte has been shifted in, the flip-flops contain the CRC: CRC=FF[8..1].

An easy method to check if there were no transmission errors is to calculate the CRC of the whole read-out data stream including the CRC Byte. When the calculated CRC results in 0x00, the transmission was most likely error free. If the resulting CRC is not equal to zero, then an error occurred in the transmission and the complete data stream should be ignored.

Some CRC results for example messages are given in Table 23.

ASCII String messages	CRC result
-None-	0x00
"A"	0xC0
"123456789"	0xF4
a string of 256 upper case "A" characters with no line breaks	0x8E

Table 23: CRC examples

Rain-/Light-Sensor IC for Automotive

7.9 Global Timing Diagrams

A global timing diagram with separate SM-RO cycles is given in Figure 23. After power-up there is a Power-On-Reset phase (POR) to initialize the sensor into a reset state. When the device is ready to accept the first command, the *DR* pin goes high. In Figure 23 the first command is the WR command to define the contents of the user registers (optionally). The first measurement cycle is initiated by uploading a SM command. After completion of the measurement cycle, the *DR* goes high. This indicates that the read-out cycle can be started. A RO command has to be uploaded to bring the data on the *MISO* pin. When the read-out is completed, a new measurement cycle can be started. In Figure 23 a SM command is used. This starts a next measurement cycle. Once *DR* is high, a read-out can be done again.

In between different Measurement/Read-Out cycles, the user registers can be changed with WR commands. Optionally those registers can be read back with the RR command to check if the right values were uploaded.

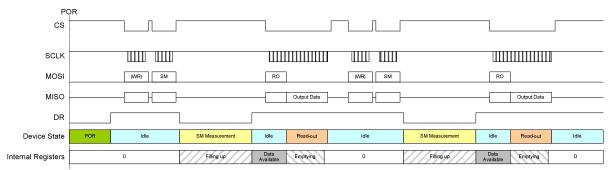


Figure 23: Global timing diagram with separate SM-RO

Figure 24 shows a timing diagram wherein separate SM-RO cycles are mixed with combined SM-RO cycles. After the Power-On-Reset phase, a SM measurement cycle is started. Once the *DR* pin is high, the data can be read out. A SM command with extra clocks is used to combine the read-out and the start of the next measurement cycle. With the extra clocks, the data of the internal registers is transferred to the *MISO* pin. When the *CS* pin goes high, the next measurement cycle (SM) will be started.

Once the *DR* pin is high, a normal RO command is uploaded to bring the data to the *MISO* pin. If needed, the settings in the user registers can be changed with the WR command and optionally the RR command can be used to check if the right values were uploaded.

A new measurement cycle can be started with e.g. a normal SM command. When the *DR* pin is high, the data can be transferred by uploading e.g. a SM command that combines the read-out and the start of a new measurement cycle.

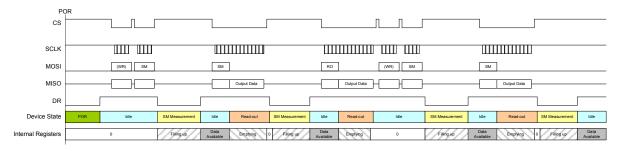


Figure 24: Global timing diagram with separate SM-RO and combined SM-RO together



Rain-/Light-Sensor IC for Automotive

8 Unique Features

The MLX75308 is designed especially to interface the highly demanding RainLight module.

The MLX75308 has a large and programmable dynamic range covering a wide range of input signals (variation of windshield darkness, variation of light influences outside, variation of LED & PD (photodiode) performance due to mechanical setup, temperature or aging).

The MLX75308 has a flexible and versatile digital SPI interface with large programmability and easy to use 16bit ADC readout.

The MLX75308 has internal compensation for both large sunlight effects (static & dynamic) and for parasitic 2nd order effects of low-cost PDs. Both rain as well as sun signals are measured and compensated on 16 bit level, allowing the user of the MLX75308 to create a RLS system with highest possible performance in rain-detection.

The MLX75308 has internal pre-driver to facilitate large dynamic range, and the external FETs allow for highly intense current peaks to maximise SNR and allow the usage of low cost PDs.

The MLX75308 has several diagnostic features and internal watchdog to allow the system designers to design a fail-safe RLS system.

The MLX75308 comes with 2 versatile rain channels and 3 versatile ambient channels, allowing the RLS system architect to connect to any PD he/she requires for best system performance or lowest cost

With the 3.3V power supply, sleep and standby modes, the MLX75308 is designed to offer the RLS system concept flexibility and low-power modes for different car-models.

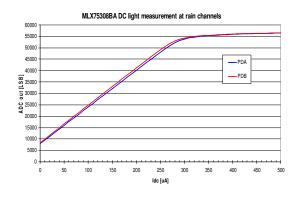
The MLX75308 comes in a small QFN4x4 leadless package, with minimum footprint and minimizes external components and ECU overhead for the RLS application.



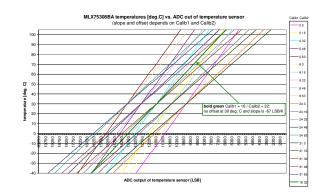
Rain-/Light-Sensor IC for Automotive

9 Performance Graphs

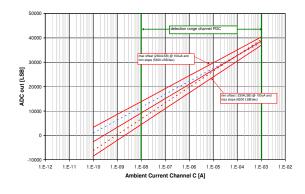
9.1 Rain Channel DC Measurement



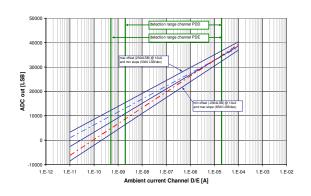
9.2 Temperature Sensor Characteristics



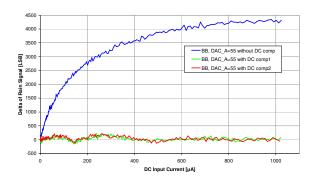
9.3 Ambient Light Channel C



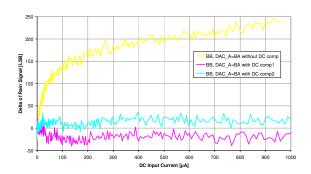
9.4 Ambient Light Channel D+E



9.5 DC Light Compensation (BP104FS)

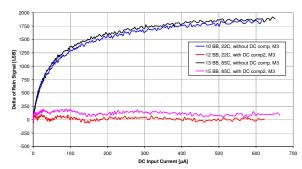


9.6 DC Light Compensation (SFH2701)



Rain-/Light-Sensor IC for Automotive

9.7 DC Light Compensation (SFH2400)

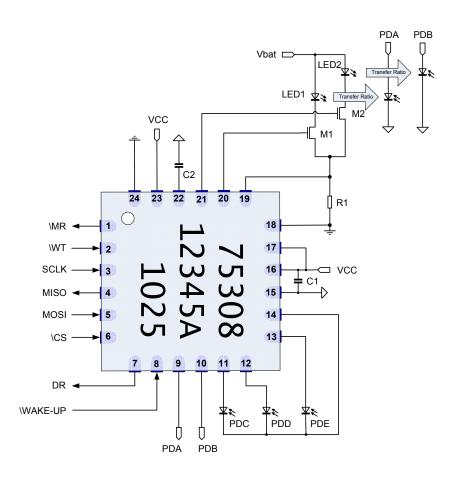


Measurement performed over temperature.

Rain-/Light-Sensor IC for Automotive

10 Application Information

10.1 Application circuit for typ. rain channel and three ambient channels

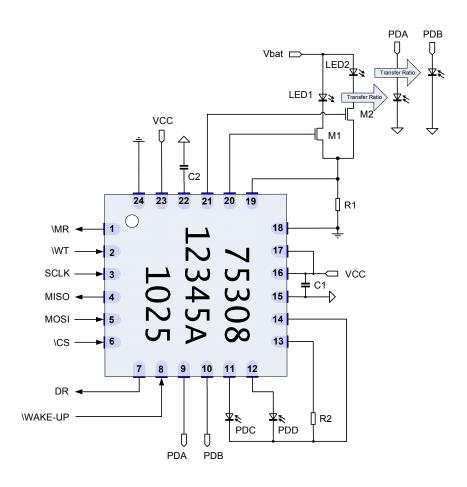


Part		Value	Description
C1	SMD capacitor	47nF	blocking capacitor, connected to analog GND
C2	SMD capacitor	68nF	blocking capacitor for int. voltage regulator, connected to analog GND
R1	SMD resistor	6.40hms	Shunt Resistor
M1			LED driver MOSFET
M2			LED driver MOSFET
LED1/2			Rain Channel Infrared LED
PDA / PDB			Rain Channel Infrared Photodiode
PDC			Photodiode with V-lambda characteristics
PDD / PDE			Photodiode

Table 24: Application circuit components for all rain- and ambient-channels used

Rain-/Light-Sensor IC for Automotive

10.2 Application circuit for typ. rain channel and two ambient channels



Component	Type	Value	Description			
C1	SMD capacitor	47nF	blocking capacitor, connected to analog GND			
C2	SMD capacitor	68nF	blocking capacitor for int. voltage regulator, connected to analog GND			
R1	SMD resistor	6.4 Ohms	Shunt Resistor			
R2	SMD resistor	56k Ohms	Ambient Light Diagnosis termination resistor			
M1			LED driver MOSFET			
M2			LED driver MOSFET			
LED1/2			Rain Channel Infrared LED			
PDA / PDB			Rain Channel Infrared Photodiode			
PDC			V-lambda Photodiode			
PDD			Photodiode			

Table 25: Application circuit components for on ambient channel disabled (but used for additional diagnosis)



Rain-/Light-Sensor IC for Automotive

11 Application Comments

The MLX75308 is featuring very sensitive current inputs on the pins 9 and 10 for rain detection and on the pins 11 to 13 for ambient light measurements in a range over several orders of magnitude. In order to achieve optimum results in the application it is recommended to consider the following hints for the design of the PCB:

- 1. Both supply voltage pins 16 (VDDA for analog circuit parts) and 23 (VDDD for digital circuit parts) shall be star-connected to the local (external) regulator output (3.0V-3.6V) in order to avoid digital disturbance injection into the analog supply.
- 2. Note that the device works with two separate gound connections: Pin 15 works as analog gnd for the sensitive input circuitry whereas pin 24 works as digital ground and as ground connection of the LED path, which carries high pulse currents.
- 3. The Exposed Pad of the package should be star-connected to the local (external) gnd pin of the regulator.
- 4. The external blocking capacitors C1 and C2 shall be placed as close as possible to the corresponding pins of the device.
- 5. The external photodiodes on the rain channel inputs as well as on the ambient light inputs shall be placed as close as possible to the corresponding pins of the device. If this is not possible due to construction reasons, the connections shall be shielded by a noise-free analog ground plane in order to avoid performance-loss due to disturbance coupling.



Rain-/Light-Sensor IC for Automotive

12 Standard information regarding manufacturability of Melexis products with different soldering processes

Our products are classified and qualified regarding soldering technology, solderability and moisture sensitivity level according to following test methods:

Reflow Soldering SMD's (Surface Mount Devices)

- IPC/JEDEC J-STD-020
 Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices (classification reflow profiles according to table 5-2)
- EIA/JEDEC JESD22-A113
 Preconditioning of Nonhermetic Surface Mount Devices Prior to Reliability Testing (reflow profiles according to table 2)

Wave Soldering SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

- EN60749-20
 - Resistance of plastic- encapsulated SMD's to combined effect of moisture and soldering heat
- EIA/JEDEC JESD22-B106 and EN60749-15
 Resistance to soldering temperature for through-hole mounted devices

Iron Soldering THD's (Through Hole Devices)

EN60749-15
 Resistance to soldering temperature for through-hole mounted devices

Solderability SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

 EIA/JEDEC JESD22-B102 and EN60749-21 Solderability

For all soldering technologies deviating from above mentioned standard conditions (regarding peak temperature, temperature gradient, temperature profile etc) additional classification and qualification tests have to be agreed upon with Melexis.

The application of Wave Soldering for SMD's is allowed only after consulting Melexis regarding assurance of adhesive strength between device and board.

Melexis is contributing to global environmental conservation by promoting **lead free** solutions. For more information on qualifications of **RoHS** compliant products (RoHS = European directive on the Restriction Of the use of certain Hazardous Substances) please visit the quality page on our website: http://www.melexis.com/quality.aspx



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13 ESD Precautions

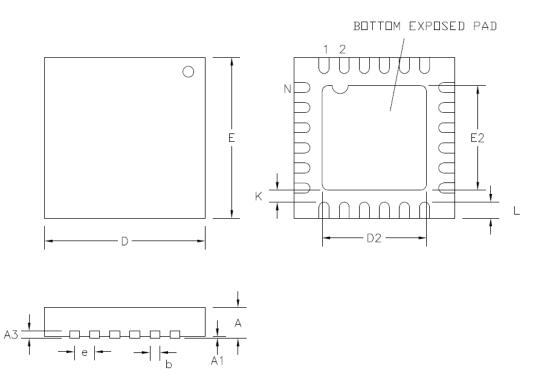
Electronic semiconductor products are sensitive to Electro Static Discharge (ESD). Always observe Electro Static Discharge control procedures whenever handling semiconductor products.

14 FAQ

See FAQ document

Rain-/Light-Sensor IC for Automotive

15 Package Information



	DxE	N	е		A	A1	A3	D2	E2	L	K	b
	All dimensions in mm											
Quad	4 x 4	24	0.50 ±0.05	min	0.80	0.00	0.20	2.50	2.50	0.35	0.20	0.18
	4 7 4	24	0.50 ±0.05	max	1.00	0.05	REF	2.70	2.70	0.45	_	0.30

Table 26: Package dimensions

Package	Θjc [°C/W]	Θja [°C/W] (JEDEC 1s0p board)	Θja [℃/W] (JEDEC 1s2p board)
QFN 4x4	16	154	50

Table 27: ϑ_{JA} values



Rain-/Light-Sensor IC for Automotive

16 Disclaimer

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